

AC107/AC107S 2-Channel High Performance Voice Capture ADCs with I2C/I2S

1 Features

- 103 dB dynamic range(A-weight) @ 0 dB boost gain
- -85 dB THD+N @ 0 dB boost gain
- ADC sample rates supported: 8kHz~96kHz
- Two fully differential microphone inputs
- One digital microphone SCLK output @ 1.024M~3.072M
- PLL support a wide clock input for 6/12MHz, 6.144MHz, 5.6448MHz,13MHz ,16MHz,19.2MHz and 24MHz
- Programmable low noise Microphone Bias 1.8V~3.0V
- <20mW 2-ADC for low power consumption application

2 Applications

- Smart Voice Assistant Systems
- Voice Recorders
- Digital Cameras and video cameras
- Voice Conferencing System

3 Description

The AC107 is a highly integrated 2-channel ADC with I2S/TDM output transition. It's designed for multi-microphone array in high definition voice capture and recognition application platforms.

The integrated digital PLL supports a large range of input/output frequencies, and it can generate required system clocks from common reference clock such as 6-/12-MHz, 6.144-/12.288-MHz, 5.6448-/11.2896-MHz, 13MHz, 19.2MHz, 24.576MHz and other non-standard audio

system clocks. The audio sample 8kHz, 11.025kHz, 12kHz, 16kHz, 22.05kHz, 24kHz, 32kHz, 44.1kHz, 48kHz is supported.

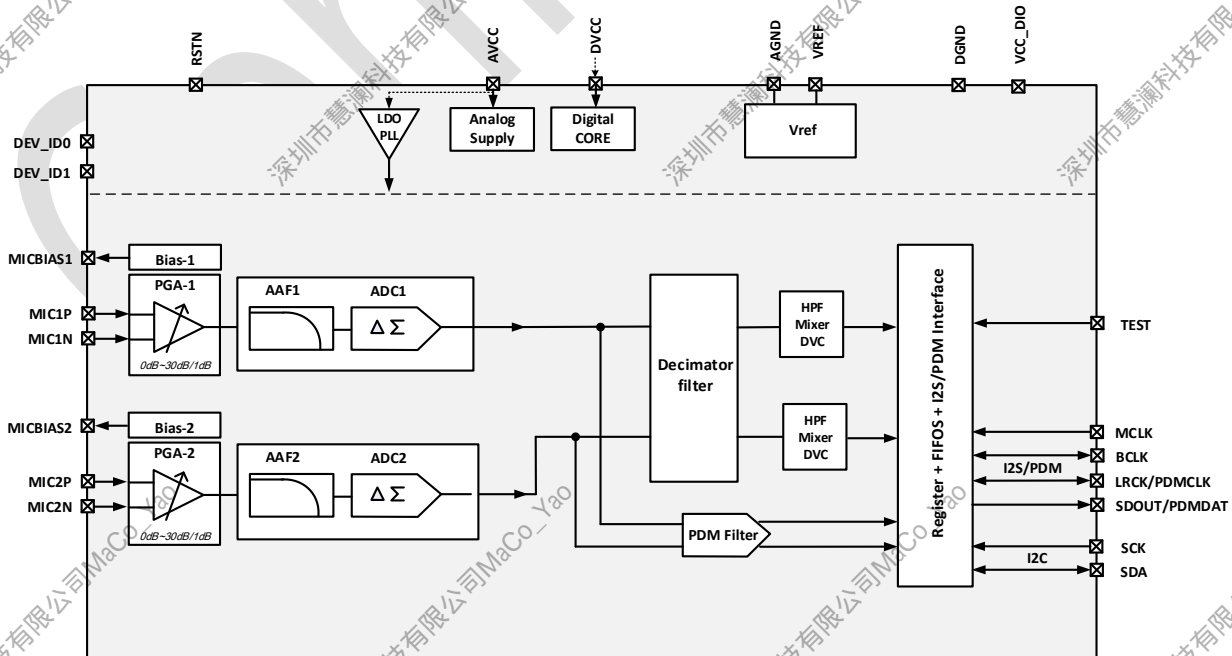
The AC107 integrates stereo synchronized ADCs with independent programmable mic bias voltage and mic boost amplifier to deliver valid channel data that channel crosstalk can be eliminated. The analog input port MIC1P/N~MIC2P/N is designed as two differential microphone pin or single-ended line-in pin. Independent digital volume controllers are provided in each channel.

The AC107 can transit its 2 channels output data over the I2S port by standard I2S or PCM format. Also, one to eight device can be combined to transit up to 16 channels output data by a single TDM line. Furthermore, A new format called encoding mode can be used to transit 16 channels data when the I2S format of AP is normal protocol types.

The AC107 is controlled through TWI (2-wire serial interface, I2C compatible). The clock supports up to 400 KHz rate. It works only in the slave mode.

Device Information

Part Number	Package	Body Size
AC107	QFN-20	3.0mm*3.0mm
AC107S	QFN-24	4.0mm*4.0mm



Simplified Block Diagram

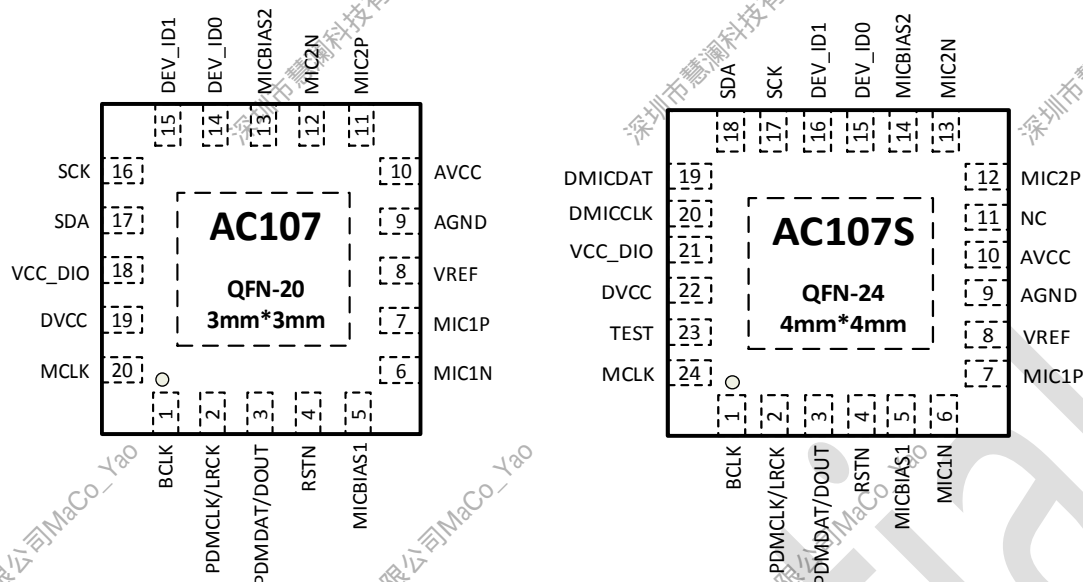
4 Revision History

Revision	Date	Description
V1.0	Dec.12, 2018	Initial internal release
V1.1	Mar. 22, 2019	Add power consumption
V1.2	Apr. 26, 2019	Add marking information and carrier
V1.3	May. 8,2019	Change carrier from tray to tape reel
V1.4	May. 20,2019	Update PGA input resistance and PDM description

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5 Pin Configuration and Functions



PIN DESCRIPTION

Pin Number		Name	I/O	Description
AC107	AC107S			
1	1	BCLK	IO	I2S interface serial bit clock
2	2	LRCK/PDMCLK	IO	I2S interface synchronous clock/PDM interface synchronous clock
3	3	SDOUT/PDMDATA	O	I2S interface serial data output/PDM interface serial data output
4	4	RSTN	I	Chip rest pin
5	5	MICBIAS1	O	Bias voltage output for MIC1
6	6	MIC1N	I	Negative differential input for MIC1
7	7	MIC1P	I	Positive differential input for MIC1
8	8	VREF	O	Internal reference voltage
9	9	AGND	G	Analog Ground
10	10	AVCC	P	The analog part Power input
--	11	NC	--	Not connected
11	12	MIC2P	I	Positive differential input for MIC2
12	13	MIC2N	I	Negative differential input for MIC2
13	14	MICBIAS2	O	Bias voltage output for MIC2
14	15	DEV_ID0	I	TWI interface device ID control
15	16	DEV_ID1	I	TWI interface device ID control
16	17	SCK	I	TWI interface serial clock input
17	18	SDA	IO	TWI interface serial data(Open-drain)
--	19	DMICDAT/SDIN	IO	Digital MIC stereo data input/I2S interface serial data input
--	20	DMICCLK	IO	Digital MIC CLK output
18	21	VCC_DIO	P	Digital power for digital I/O buffer
19	22	DVCC	P	The digital part Power input
--	23	TEST	I	Scan test for QAQC
20	24	MCLK/SYNCCLK	IO	I2S interface master input clock/synchronous clock output
EPAD	EPAD	GND	G	Digital Ground

Note: O for output, I for input, I/O for input/output, P for power, and G for ground

6 Specifications

6.1 Absolute Maximum Ratings

Over operating free-air temperature range(unless otherwise noted)

		MIN	MAX	UNIT
Supply voltage range	DVCC	-0.3	2.4	V
	AVCC	-0.3	3.9	V
	VCC_DIO	-0.3	3.9	V
Output voltage range	MBIAS	-0.3	3.0	V
Digital Input voltage to ground		-0.3	VCC_DIO+0.3	V
Analog input voltage to ground		-0.3	AVCC+0.3	V
Operating Temperature, T _A		-40	85	°C
Junction temperature, T _J		--	125	°C
Storage temperature, T _{stg}		-65	150	°C

(1) Current test performance: Pins stressed per JEDEC JESD78D(Class I, Level A) and passed with I/O pin injection current as defined in JEDEC.

(2) Over voltage performance: Supplies stressed per JEDEC JESD78D(Class I, Level A) and passed voltage injection as defined in JEDEC.

6.2 ESD Ratings

		VALUE	UNIT
V _(ESD)	Human body model(HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	±4000	V
	Charged device model(CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾	±500	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
DVCC	Input power for digital domain cell control	1.62	1.8	1.98	V
AVCC	Input power for analog part	3.0	3.3	3.63	V
VCC_DIO	Digital power for digital I/O buffer	1.62	3.3	3.63	V
V _i	Analog full-scale 0-dB input voltage	0.934	0.955	1.122	V _{rms}
V _{IH}	High Level Input Voltage	VCC_DIO=3.3V	3.3	3.63	V
		VCC_DIO=1.8V	1.8	1.98	V
V _{IL}	Low Level Input Voltage	-0.3	0	0.7	V
V _{OH}	High Level Output Voltage	2.7	3.3	3.63	V
V _{OL}	Low Level Output Voltage	-0.3	0	0.4	V
C _{OUT}	Digital output load capacitance			10	pF

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		AC107	UNIT
θ _{JA}	Junction-to-ambient thermal resistance	31.9	°C/W
θ _{JC}	Junction-to-case(top) thermal resistance	18.2	
θ _{JB}	Junction-to-board thermal resistance	10.1	

(1) Thermal metrics are calculated refer to JEDEC document JESD51-2.

6.5 Analog Characteristics

At 25°C, AVCC=3.3V, DVCC=1.8V, VCC_DIO=3.3V, 24-bit audio data, 1kHz sine wave input

Parameter	Test Conditions	Min	Typ	Max	Unit
AUDIO ADC					
Full scale input	PGA gain = 0dB, @THD<-40dB		0.5		Vrms
DR(A-weighted)	PGA gain = 0dB, @Fs=16KHz		103		dB
THD+N			-85		dB
DR(A-weighted)	PGA gain = 12dB, @Fs=16KHz		102		dB
THD+N			-84		dB
DR(A-weighted)	PGA gain = 24dB, @Fs=16KHz		94		dB
THD+N			-82		dB
DR(A-weighted)	PGA gain = 30dB, @Fs=16KHz		89		dB
THD+N			-81		dB
DR(A-weighted)	PGA gain = 0dB, @Fs=48KHz		103		dB
THD+N			-82		dB
DR(A-weighted)	PGA gain = 24dB, @Fs=48KHz		92		dB
THD+N			-80		dB
PSRR	217 Hz, 100 mVPP on AVCC, differential input		71		dB
Crosstalk (L/R)	10mV, 1KHz, 30dB Gain		-100		dB
MICBIAS					
Output Scale		1.8	3	AVCC	V
Bias Current			4		mA
Noise Level(A-weighted)		1.7	4		uV

6.6 Electrical Characteristics

At 25°C, AVCC=3.3V, DVCC=1.8V, VCC_DIO=3.3V, MCLK=12.288MHz I2S, 32bit

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
POWER CONSUMPTION						
Standby	Default register state after Power on and Reset, MCLK/BCLK/LRCK off	I _{1.8V}		0.46		uA
		I _{3.3V}		0.22		uA
1-ADC	PGA gain = 0dB, @Fs = 16KHz	I _{1.8V}		0.271		mA
2-ADC		I _{3.3V}		1.682		mA
		I _{1.8V}		0.319		mA
		I _{3.3V}		3.094		mA
1-ADC	PGA gain = 0dB, @Fs = 48KHz	I _{1.8V}		0.6		mA
2-ADC		I _{3.3V}		1.881		mA
		I _{1.8V}		0.745		mA
		I _{3.3V}		3.483		mA
1-ADC	PGA gain = 0dB, @Fs = 96KHz	I _{1.8V}		1.166		mA
2-ADC		I _{3.3V}		2.169		mA
		I _{1.8V}		1.448		mA
		I _{3.3V}		4.106		mA

7 Detailed Descriptions

7.1 Overview

The AC107 is a highly integrated 2-channel ADC with I2S/TDM output transition. It's designed for multi-microphone array in high definition voice capture and recognition application platforms.

The integrated digital PLL supports a large range of input/output frequencies, and it can generate required system clocks from common reference clock such as 6-/12-MHz, 6.144-/12.288-MHz, 5.6448-/11.2896-MHz, 13MHz, 19.2MHz, 24.576MHz and other non standard audio system clocks. The audio sample 8kHz, 11.025kHz, 12kHz, 16kHz, 22.05kHz, 24kHz, 32kHz, 44.1kHz, 48kHz is supported.

The AC107 integrates stereo synchronized ADCs with independent programmable mic bias voltage and mic boost amplifier to deliver valid channel data that channel crosstalk can be eliminated. The analog input port MIC1P/N ~MIC2P/N is designed as two differential microphone pin or single-ended line-in pin. Independent digital volume controllers are provided in each channel.

The AC107 can transit its 2 channels output data over the I2S port by standard I2S or PCM format. Also, one to eight device can be combined to transit up to 16 channels output data by a single TDM line. Furthermore, A new format called encoding mode can be used to transit 16 channels data when the I2S format of AP is normal protocol types.

The device includes several DSP features such as high-pass filter, mixer, and volume control.

AC107 is controlled through TWI (2-wire serial interface). The clock supports up to 400 KHz rate. It works only in the slave mode.

The device is available in a 20-pin 3mm*3mm QFN package or in a 24-pin 4mm*4mm QFN package.

7.2 Functional Block Diagram

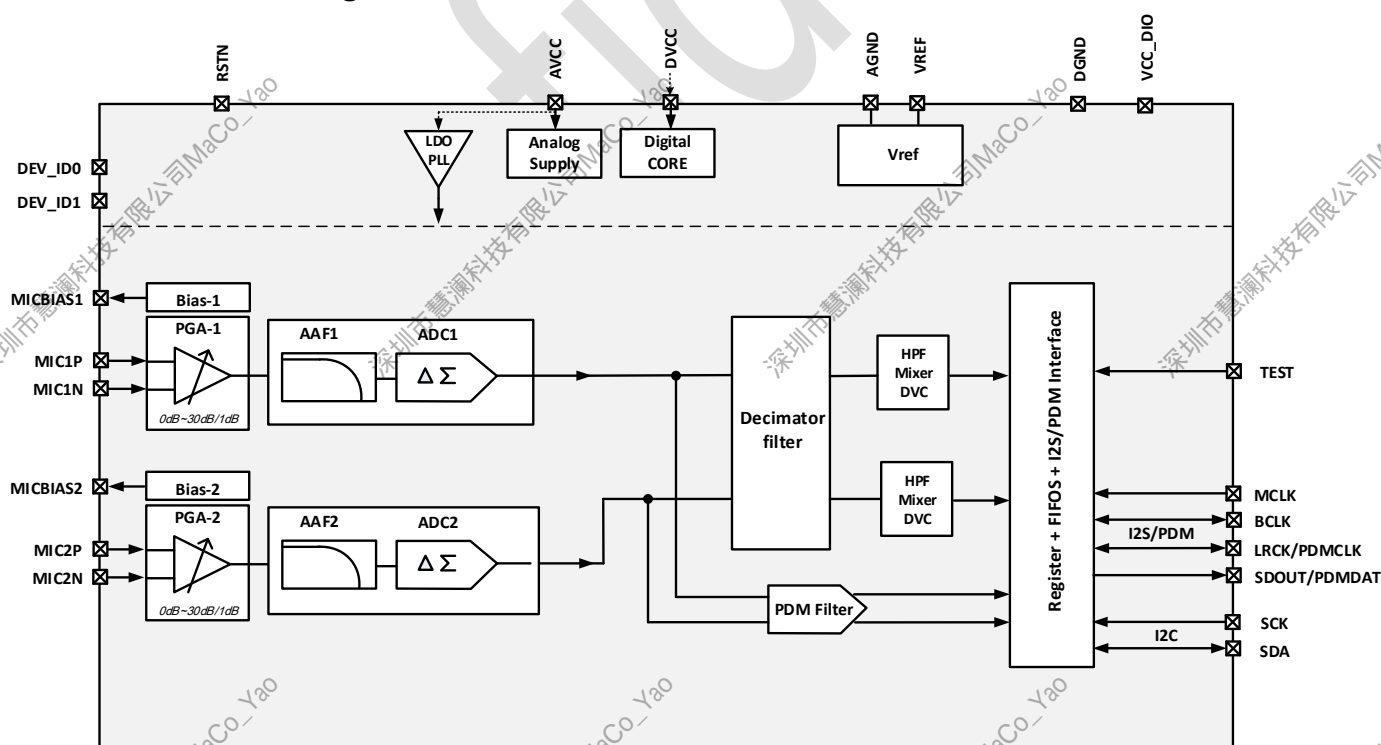


Figure 7-1. AC107 Block Diagram

7.3 Feature Description

7.3.1 Power

AC107 has a clear power management to make sure analog circuit work in a high performance status. All the supply voltages are illustrated in the below figure.

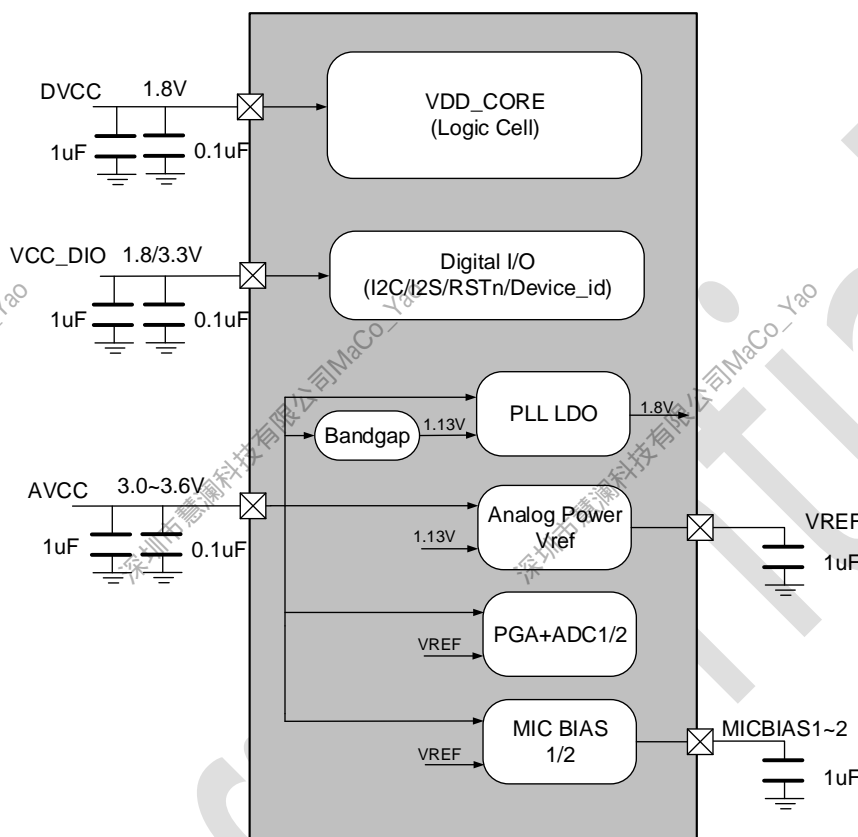


Figure 7-2. Power Management

DVCC is the digital power input for the logic cell control. AVCC is the analog power supply rail input to the analog circuit, which usually needs a clear LDO to make sure analog circuit work in a high performance status. VREF is designed to be a low noise voltage as analog power reference. VDD_DIO is digital I/O power for TWI, I2S, Device_IDx and RSTN.

The power supplies are designed to operate from 3.0 V to 3.63 V for AVCC, from 1.62 V to 1.98 V for DVCC and from 1.62 V to 3.63 V for VCC_DIO. Any value out of these ranges must be avoided to ensure the correct behavior of the device. The power supplies must be well regulated. Placing a decoupling capacitor close to the AC107 improves the performance of the device. A low equivalent-series-resistance (ESR) ceramic capacitor with a value of 0.1 μF is a typical choice. If the AC107 is used in highly noise-sensitive circuits, it is recommended to add a small LC filter on the AVCC connections.

When the AC107 is not working, it need to set the supply properly to prevent power leakage. It's best to power off all the supply.

7.3.2 Reset

There are a Power-Reset circuit in AC107 used to reset all the circuit and register to a standby state after power up. The Power-Reset circuit make all the supply power need no specific timing.

The power reset and soft reset diagram is below:

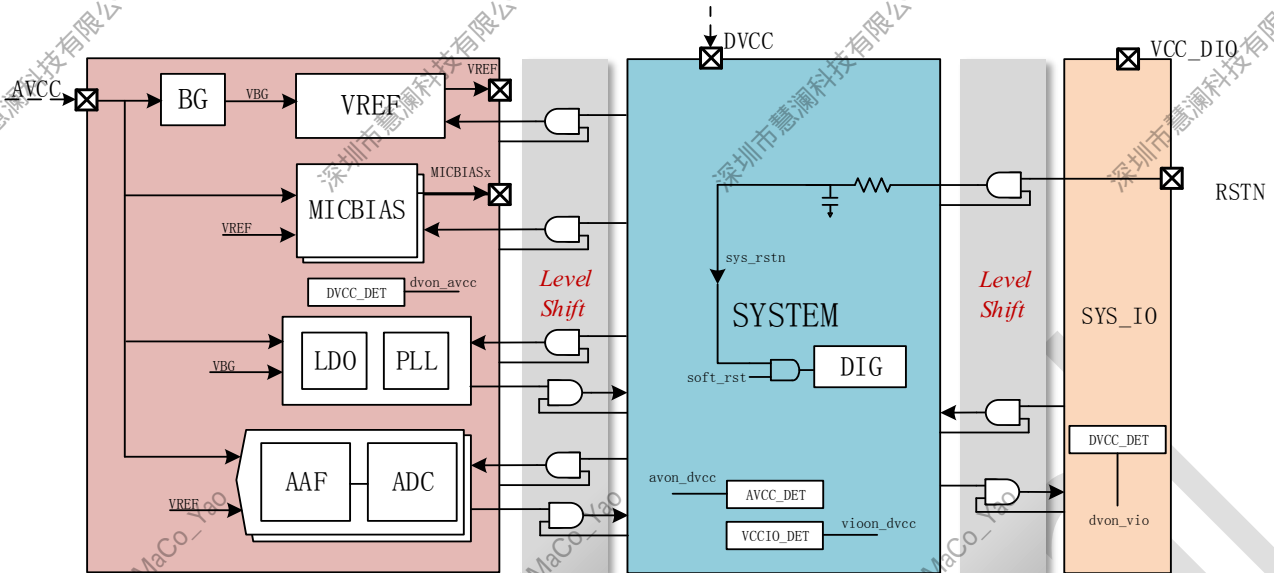


Figure 7-3. Reset Management

7.3.3 Clock

The system clock (SYSCLK) of AC107 must be $256 \times fs$ ($fs=48\text{KHz}$ or 44.1KHz). So the system should arrange the divider to generate 12.288MHz for audio clock series of 48KHz or 11.2896MHz for series of 44.1KHz.

SYSCLK, which always provided by external clock or internal PLL, can be selected from MCLK/I2S_BCLK or PLL, while the PLL reference clock can be selected from MCLK, I2S_BCLK or PDMCLK. SYSCLK is the clock reference of ADC, DVC, MIXER, HPF and I2S module except TWI. If MCLK&BCLK are both not 12.288MHz for ADC 48KHz series sample rate or 11.2896MHz for ADC 44.1KHz series sample rate, SYSCLK must be selected from PLL. SYSCLK always need to be configured in these cases.

SCK pin is always an external clock input pin and the clock is used as the reference of the TWI clocking zone.

AC107 CLOCK

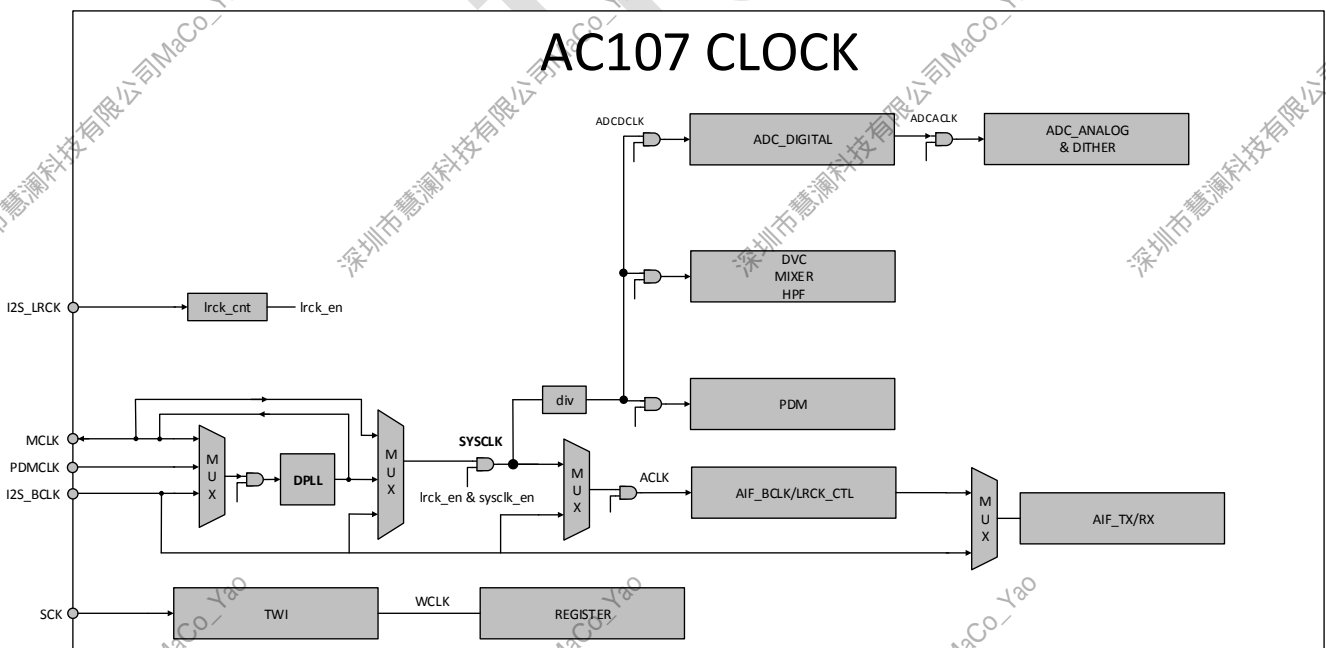


Figure 7-4. Clock Management Unit

The clock management related registers are *Reg[0x20]~Reg[0x22]*.

7.3.4 PLL

A Phase-Locked Loop (PLL) is designed to cover a flexible input clock range from 400KHz to 24MHz. The clock sources of the PLL can be set to MCLK, BCLK or PDMCLK by setting register *Reg[0x20]*. The PLL output is always used to provide the system clock (SYSCLK) for AC107 when 12.288MHz or 11.2896MHz cannot be provided from MCLK and BCLK. The PLL transmit formula as below:

$$F_{OUT} = (F_{IN} * N) / ((M1+1) * (M2+1) * (K1+1) * (K2+1));$$

Table 7-1. clock setting for SYSCLK=12.288MHz

FIN	M1	M2	Fref	N	Fvco	K1	K2	FOUT
400K	0	0	400K	983	393.2M	15	1	12287500
512K	0	0	512K	960	491.52M	19	1	12288000
768K	0	0	768K	640	491.52M	19	1	12288000
800K	0	0	800K	768	614.4M	24	1	12288000
1.024M	0	0	1.024M	480	491.52M	19	1	12288000
1.6M	0	0	1.6M	384	614.4M	24	1	12288000
2.048M	0	0	2.048M	240	491.52M	19	1	12288000
3.072M	0	0	3.072M	160	491.52M	19	1	12288000
4.096M	0	0	4.096M	120	491.52M	19	1	12288000
6M	4	0	1.2M	512	614.4M	24	1	12288000
6.144M	1	0	3.072M	160	491.52M	19	1	12288000
12M	9	0	1.2M	512	614.4M	24	1	12288000
13M	12	0	1M	639	639M	25	1	12288462
15.36M	9	0	1.536M	320	491.52M	19	1	12288000
16M	9	0	1.6M	384	614.4M	24	1	12288000
19.2M	11	0	1.6M	384	614.4M	24	1	12288000
19.68M	15	1	615K	999	614.385M	24	1	12287700
24M	9	0	2.4M	256	614.4M	24	1	12288000

Table 7-2. clock setting for SYSCLK=11.2896 MHz

FIN	M1	M2	Fref	N	Fvco	K1	K2	FOUT
400K	0	0	400K	1016	406.4M	17	1	11288889
512K	0	0	512K	882	451.584M	19	1	11289600
768K	0	0	768K	588	451.584M	19	1	11289600
800K	0	0	800K	508	406.4M	17	1	11288889
1.024M	0	0	1.024M	441	451.584M	19	1	11289600
1.6M	0	0	1.6M	254	406.4M	17	1	11288889
2.048M	1	0	1.024M	441	451.584M	19	1	11289600
3.072M	0	0	3.072M	147	451.584M	19	1	11289600
4.096M	3	0	1.024M	441	451.584M	19	1	11289600
6M	1	0	3M	143	429M	18	1	11289474
6.144M	1	0	3.072M	147	451.584M	19	1	11289600
12M	3	0	3M	143	429M	18	1	11289474
13M	12	0	1M	429	429M	18	1	11289474
15.36M	14	0	1.024M	441	451.584M	19	1	11289600
16M	24	0	640K	882	564.48M	24	1	11289600
19.2M	4	0	3.84M	147	564.48M	24	1	11289600
19.68M	13	1	703K	771	541.90M	23	1	11289643
24M	24	0	960K	588	564.48M	24	1	11289600

7.3.5 TWI Interface

TWI is a 2-wire (SCK/SDA) half-duplex serial communication interface, supporting only slave mode. SCK is used for clock and SDA is used for data. SCK clock supports up to 400KHz rate and SDA data is an open drain structure.

A master controller initiates the transmission by sending a “start” signal, which is defined as a high-to-low transition at SDA while SCK is high. The first byte transferred is the slave 7-bit address followed by a R/W bit. The 7-bit chip address changed by external two Pins DEV_ID0 and DEV_ID1. The chip address is defined by Table 7-3 below. The R/W bit indicates the slave data transfer direction. Once an acknowledge bit is received, the data transfer starts to proceed on a byte-by-byte basis in the direction specified by the R/W bit. The master can terminate the communication by generating a “stop” signal, which is defined as a low-to-high transition at SDA while SCK is high.

Table 7-3. The Chip Slave address

7-bit Address	DEV_ID1	DEV_ID0
0x36(011 0110)	0	0
0x37(011 0111)	0	1
0x38(011 1000)	1	0
0x39(011 1001)	1	1

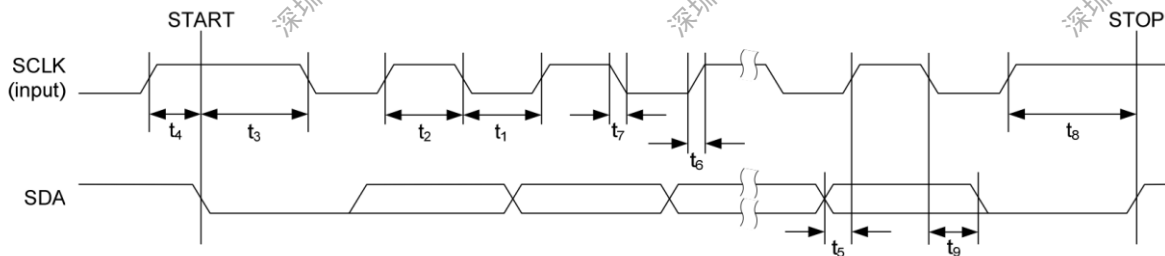
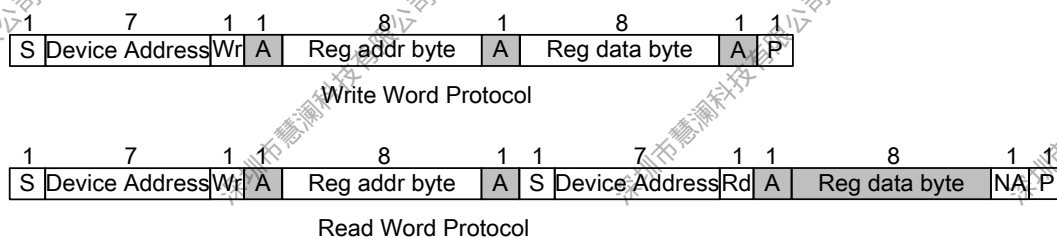


Figure 7-5. TWI Interface

Table 7-4. TWI Timing Requirement

Parameter	Symbol	Min	Typ	Max	Units
SCK Frequency				400	KHz
SCLK Low Pulse-Width	t ₁	1300			ns
SCLK High Pulse-Width	t ₂	600			ns
Hold Time(Start Condition)	t ₃	600			ns
Setup Time(Start Condition)	t ₄	600			ns
Data Setup Time	t ₅	100			ns
SDA,SCLK Rise Time	t ₆			300	ns
SDA,SCLK Fall Time	t ₇			300	ns
Setup Time(Stop Condition)	t ₈	600			ns
Data Hold Time	t ₉			900	ns
Pulse Width of Spikes suppressed	t _{ps}			30	ns

The formats of “write” and “read” instructions are shown in below.



S: Start Condition
P: Stop Condition
A: 0 for ACK, 1 for NACK
Wr: 0 for Write Command
Rd: 1 for Read Command

Slave Address: 7-bit Device Address
Command Code: 8-bit Register Address
Data Byte: 8-bit Register data
□ : Master-to-Slave
■ : Slave-to-Master

Figure 7-6. TWI Read and Write

7.3.6 I2S/PCM Interface

There are only one I2S/PCM output engine which can be configured as master mode or slave mode in AC107. The I2S/PCM interfaces provide flexible transit protocol to support varied formats processors.

The serial data is normally driven on negative edge of BCLK. MSB bit of data is normally transmitted first. In the general case, the digital audio interface uses three pins as below:

- BCLK: Bit clock for data synchronization
- LRCK: Left/Right data alignment clock
- SDOUT: output data for ADC1~ADC2 data

I2S audio interface support three different data protocol types below.

- I2S/PCM normal mode
- I2S/PCM TDM mode
- I2S/PCM Encoding mode

I2S/PCM normal mode support four different data format types below. Normal mode is used to transmit 2 channel data on left and right channel simultaneously.

- I2S justified mode
- Left justified mode
- Right justified mode
- PCM short/long frame mode

I2S/PCM TDM mode support four different data format types below. TDM mode is used to transmit up to 16 channel data on timeslot0~timeslot15 when eight AC107 work simultaneously.

- I2S justified TDM mode
- Left justified TDM mode
- Right justified TDM mode
- PCM short/long frame TDM mode

I2S/PCM Encoding mode support four different data format types below. Encoding mode is used to transmit up to 16 channel data using normal I2S format by setting the I2S rate to multi-times of ADC. For example, when the sample rate of ADCs is 16KHz, I2S/PCM Encoding mode can transit 8 channel data by setting I2S LRCK to $16\text{KHz} \times (8/2)$. And the last 4 bits of the sample data indicate the channel number.

- I2S justified Encoding mode
- Left justified Encoding mode

- Right justified Encoding mode
- PCM short/long frame Encoding mode

The timing of I2S in Master mode shows below:

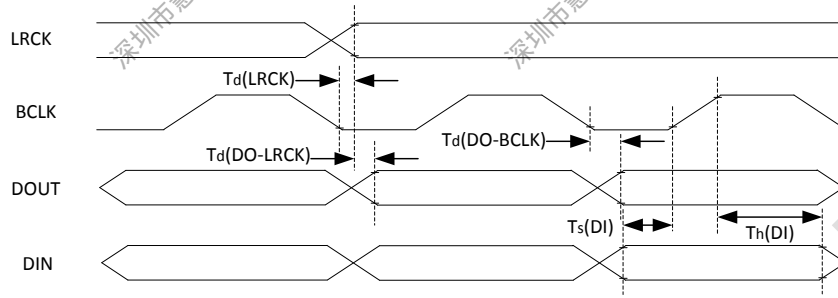


Figure 7-7. I2S Master Mode Timing

Table 7-5. I2S Timing in Master Mode

PARAMETER		MIN	MAX	UNITS
Td(LRCK)	LRCK delay		10	ns
Td(DO-LRCK)	LRCK to DOUT delay(For LJF)		10	ns
Td(DO-BCLK)	BCLK to DOUT delay		10	ns
Ts(DI)	DIN setup	4		ns
Th(DI)	DIN hold	4		ns
Tr	BCLK Rise time		8	ns
Tf	BCLK Fall time		8	ns

The timing of I2S in slave mode shows below:

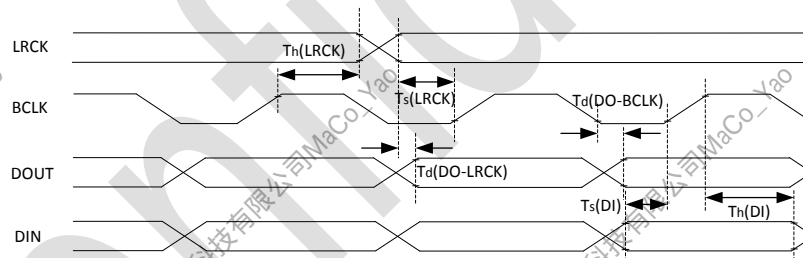


Figure 7-8. I2S Slave Mode Timing

Table 7-6. I2S Timing in Slave Mode

PARAMETER		MIN	MAX	UNITS
Ts(LRCK)	LRCK setup	4		ns
Th(LRCK)	LRCK hold	4		ns
Td(DO-LRCK)	LRCK to DOUT delay(For LJF)		10	ns
Td(DO-BCLK)	BCLK to DOUT delay		10	ns
Ts(DI)	DIN setup	4		ns
Th(DI)	DIN hold	4		ns
Tr	BCLK Rise time		4	ns
Tf	BCLK Fall time		4	ns

The I2S/PCM management related registers are *Reg[0x30]~Reg[0x3D]*.

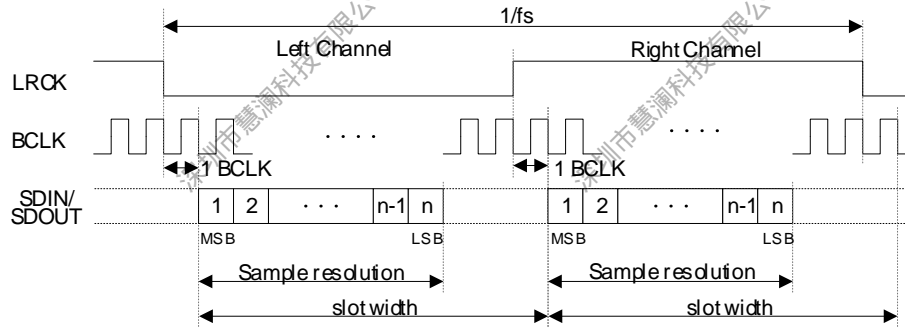


Figure 7-9. I2S Justified mode

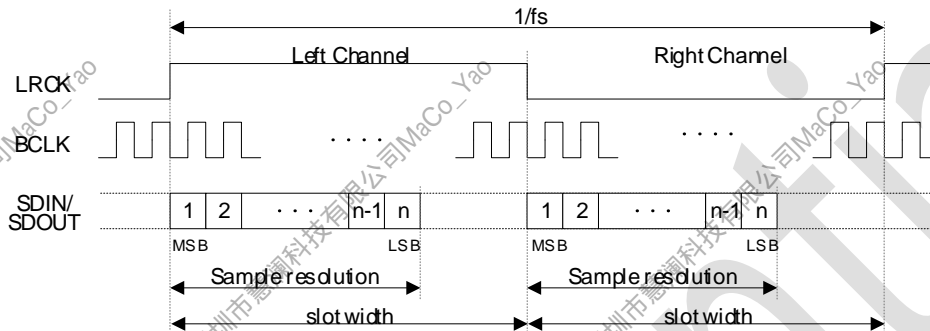


Figure 7-10. Left Justified mode

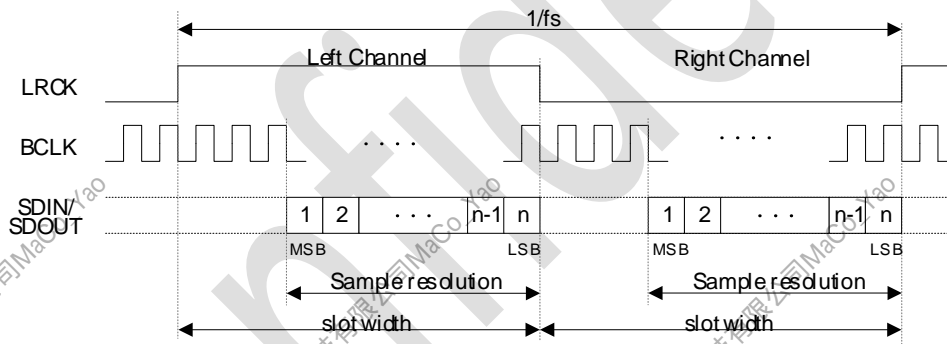


Figure 7-11. Right Justified mode

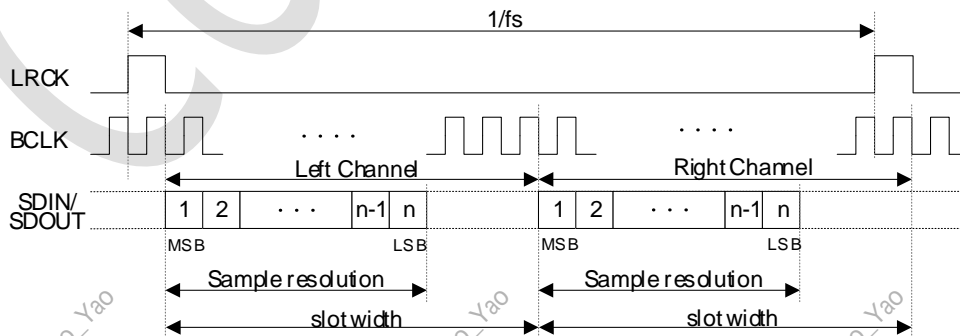


Figure 7-12. PCM mode A(Offset=1)

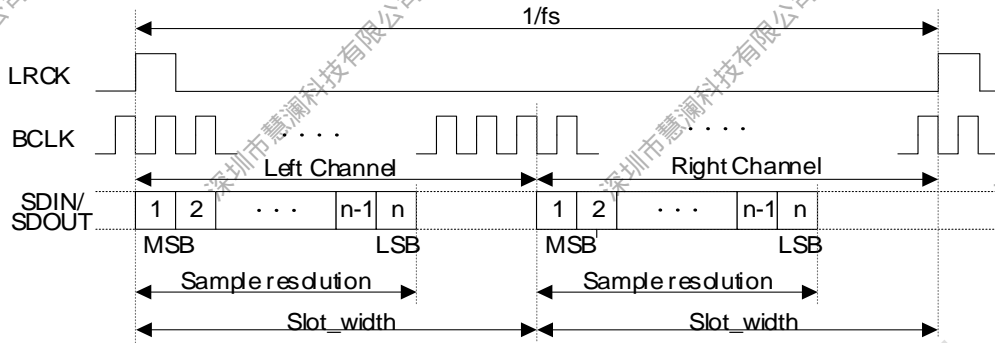


Figure 7-13. PCM mode B(Offset=0)

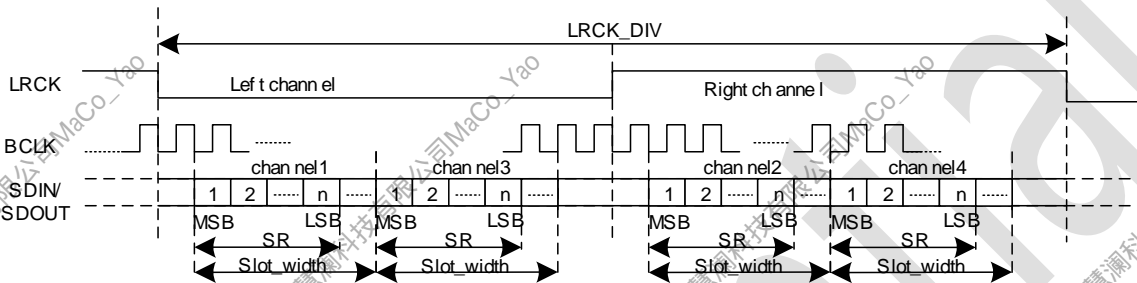


Figure 7-14. I2S TDM mode

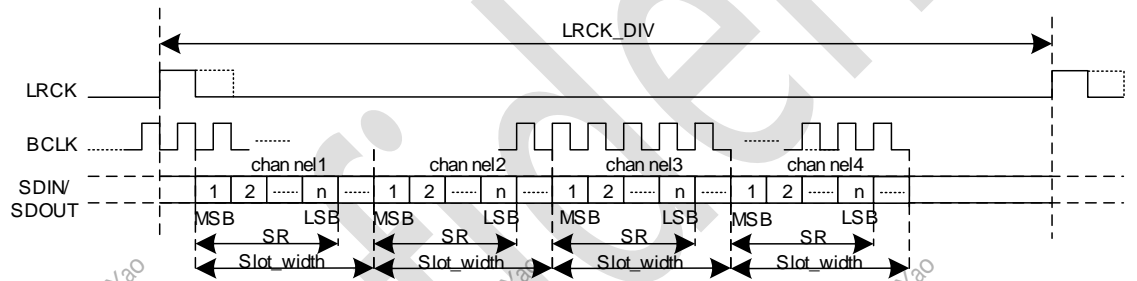


Figure 7-15. PCM TDM mode

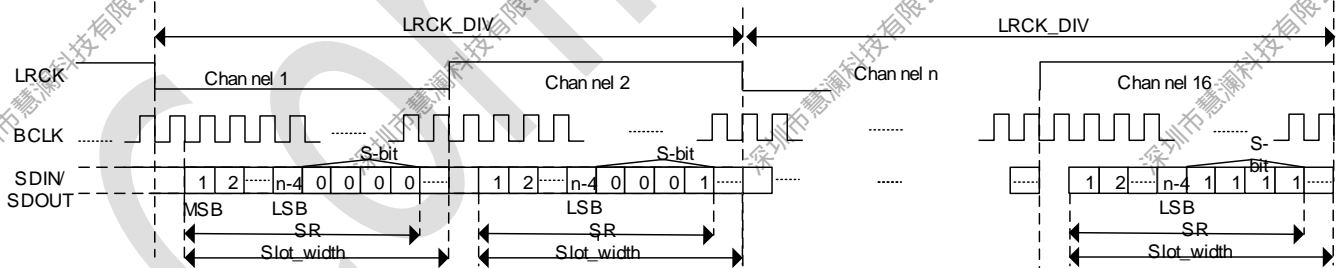


Figure 7-16. I2S Encoding mode

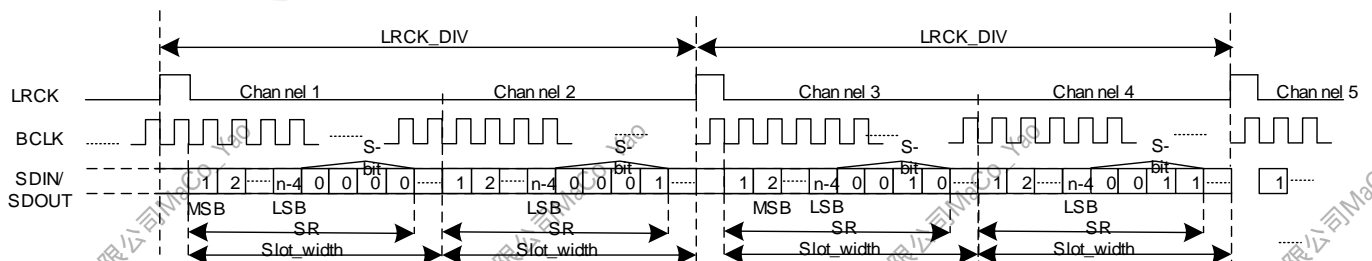


Figure 7-17. PCM Encoding mode

7.3.7 Analog Microphone Input

MIC1P/N, MIC2P/N provide differential input to the ADC1, ADC2 record path. MICIN is high impedance, low capacitance input suitable for connection to a wide range of differential microphones of different dynamics and sensitive. There are two independent AAF (Anti-Alias Filter) and PGA(Pre-Gain Amplifier) for the two differential microphone inputs. The gain for each pre-amplifier can be set independently using MIC1BOOST, MIC2BOOST. Two MICBIASx (x=1~2) provide reference voltage for electret condenser type (ECM) microphones.

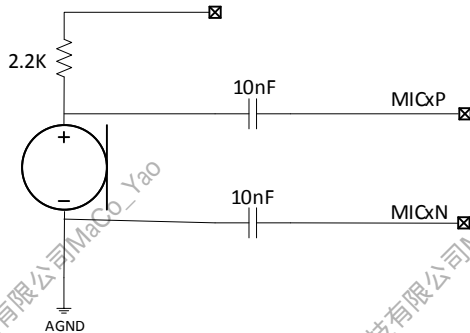


Figure 7-18. Suggested Single-Ended Mic Input

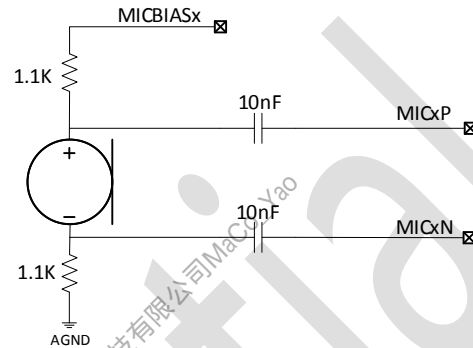


Figure 7-19. Suggested Differential Mic Input

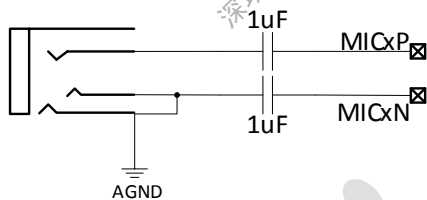


Figure 7-20. Suggested Single-Ended Line-in

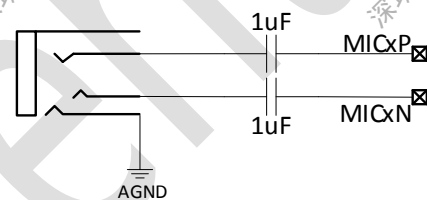


Figure 7-21. Suggested Differential Line-in

7.3.8 Analog ADC Data Path

The analog ADC data path includes separate programmable Pre-gain amplifier (PGA), anti-aliasing low-pass filter (AAF) and delta-sigma modulator (DSM). The PGA is designed to amplify input signals to the maximum full-scale signal. The AAF is designed to minimize the noise folded down to the audio band by the oversampling ADC, AAF ensure at least 60 dB attenuation at the modulator switching frequency. The DSM oversampling frequency runs at 128fs. The analog ADC data path related registers are *Reg[0xA0]~Reg[0xA9]*.

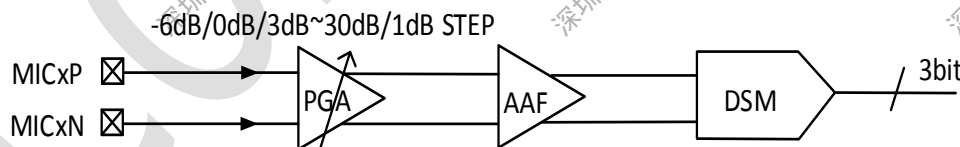


Table 7-7. PGA Gain Setting

PGA Gain Setting					
pga_gain [4:0] (decimal)	Gain Setting (dB)	Output-Referred Gain (dB)	Max Input Level (Vrms diff)	Output Level (Vrms diff)	Input Resistance (kΩ)
0	-6	0	2.000	2	16
1	0	6	1.000	2	8
2	0	6	1.000	2	8
3	0	6	1.000	2	8

4	3	9	0.710	2	100/75/50/25
5	4	10	0.632	2	100/75/50/25
...	2	100/75/50/25
N-5	N-6	N	$2/[10^{(N/20)}]$	2	100/75/50/25
...	2	100/75/50/25
31	30	36	0.032	2	100/75/50/25

NOTE: The PGA output referred gain = gain setting + 6 dB due to the single-ended to differential conversion.

7.3.9 Digital Data Path

The digital data path is provided with digital audio data source select, DSM decimation filter, HPF, volume controller and data mixing to two I2S output paths. Then the digital output of the DSM is decimated down to the required sample rate and then DC cancellation, digital amplification are implemented. Finally a digital selector and mixer is available to map any analog input into any channel or combine multiple channels into any single channel. It's separately controlled by the register *Reg[0x61]~Reg[0x7F]*.

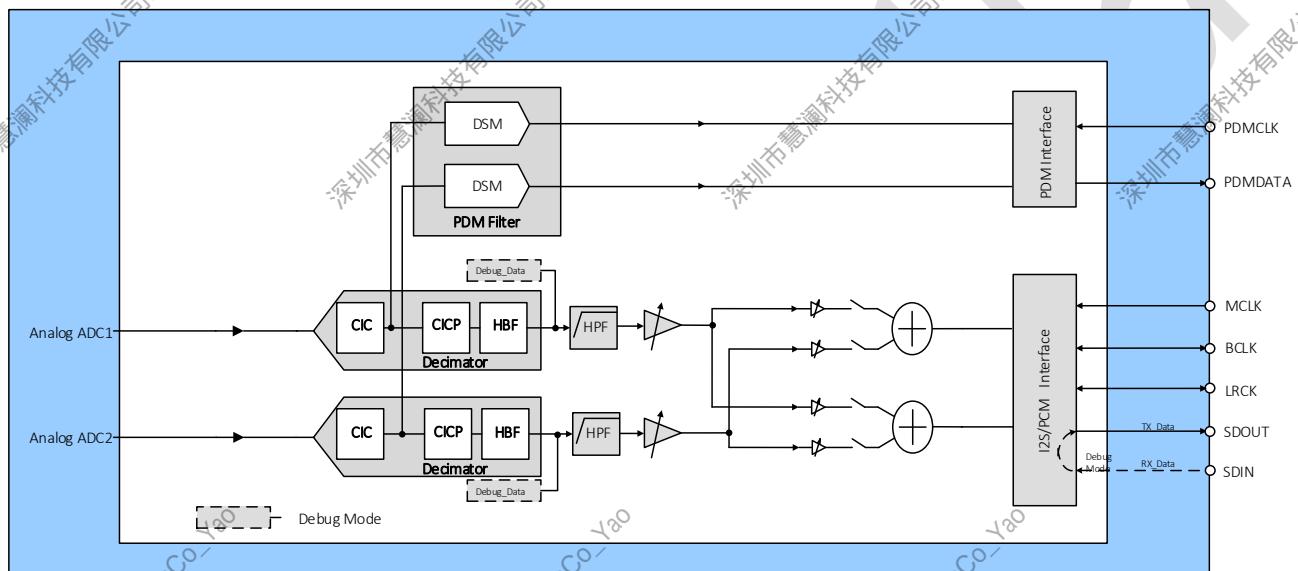


Figure 7-22. Digital Data Path

7.3.10 PDM Input and PDM Output Interface

One PDM (Pulse Density Modulation) input interface is used for dual DMICs application (Only supported on AC107S). DMICCLK is generated by AC107 and DMICDAT data comes from external DMICS. The circuit share decimation filter with audio ADC. DMICCLK can be output 64fs when the DMIC over sample rate is 32kHz~48kHz and 128fs when the DMIC over sample rate is 8kHz~24kHz (f_s = ADC sample rate).

Table 7-8. Digital Microphone Clock

Fs(kHz)	8	12	11.025	16	22.05	24	32	44.1	48
n	128	128	128	128	128	128	64	64	64
Freq(kHz)	1024	1536	1411.2	2048	2822.4	3072	2048	2822.4	3072

Digital Microphone power usually falls between the range 1.6V-3.6V, typical 1.8V. And the Clock frequency is between the the range 1.024MHz-3.072MHz.

Digital Microphone application as below:

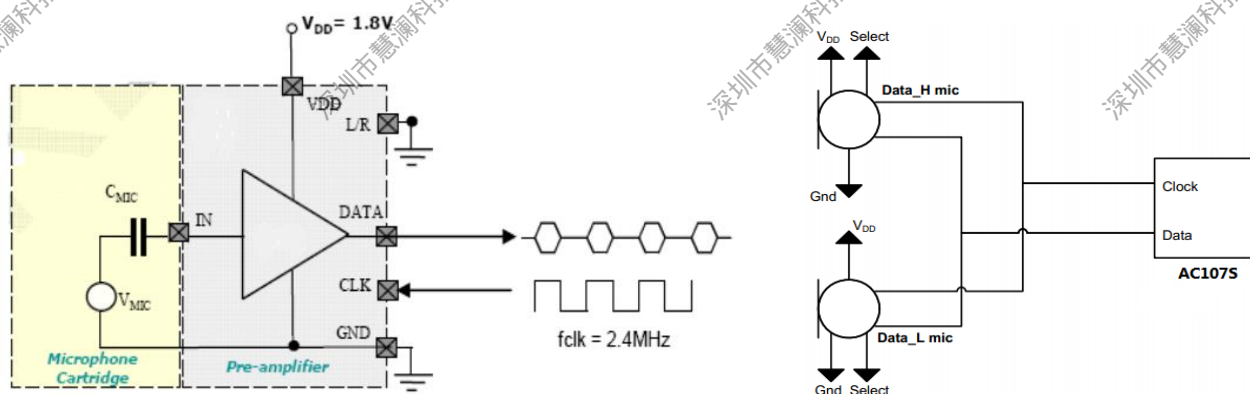


Figure 7-23. Digital Microphone Application

Digital Microphone timing as shown in Table 7-9 and Figure 7-24 below.

One PDM output interface is used to transmit the ADC channel data instead of using I2S interface. Therefore, the combination of AC107 plus AMIC can be used as 2 digital MIC. It is particularly emphasized that the timing of the DMIC PDMIN and the timing of the AC107 PDMOUT interface are somewhat different. For DMIC, because different mics drive data lines in turn, the key thing here is that the H-Z state needs to occur before valid data to ensure no bus contention occurs. Also note there is a small window (t_z) to sample data. It is essential that every valid data bit is sampled to avoid errors. As shown in figure 7-24, for DMIC PDMIN, the DAT1 data outputs during the clock low period and then turns high impedance during the high period, the DAT2 data operates in a similar way, but outputs valid data on the high clock phase. The delay time $t_{DD} > t_{Dz}$ in order to have interim H-Z state in both signals. For AC107 PDMOUT, the DAT1 and DAT2 is generated by ADC filter and no interim H-Z state required. The duty of data valid is half the f_{CLOCK} Frequency cycle.

PDM output timing as shown in Table 7-9 and Figure 7-24 below.

Table 7-9. PDM Input and Output Timing requirement

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Clock Frequency Range	f_{CLOCK}		1.024	-	3.072	MHz
Digital power for digital I/O buffer	V_{IO}		1.64	1.8	2.86	V
Logic Input High	V_{IH}		0.65 V_{IO}	-	$V_{IO}+0.3$	V
Logic Input Low	V_{IL}		-0.3	-	0.35 V_{IO}	V
Clock Duty Cycle		$f_{CLOCK} \leq 2.475$ MHz	40	-	60	%
		$2.475\text{MHz} \leq f_{CLOCK} \leq 3.072$ MHz	48	50	52	%
Delay Time for Data Assertion	t_{DD}		18	28	-	ns
Delay Time for High Z	t_{DZ}		3	-	16	ns

Table 7-10. PDM input clock

Fs(kHz)	8	12	11.025	16	22.05	24	32	44.1	48
PDMCLK(kHz)	1024	1536	1411.2	2048	2822.4	3072	2048	2822.4	3072

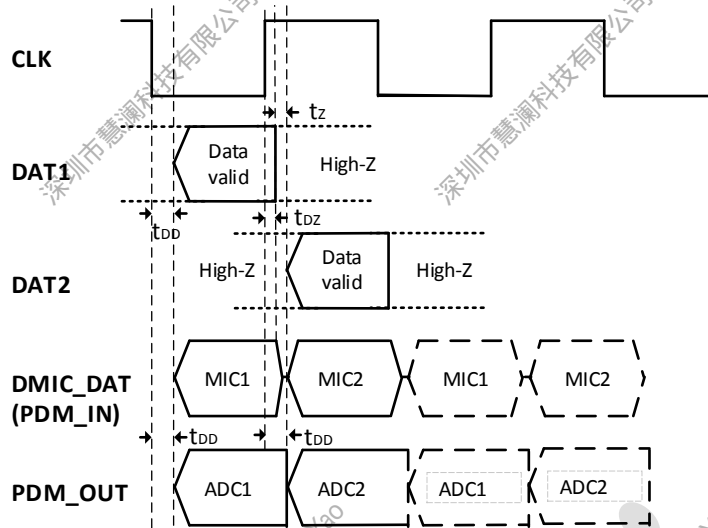


Figure 7-24. PDM Timing Diagram

7.4 Basic Setup Sequences

AC107 configuration: I2S Slave, I2S Justified mode, MCLK=12.288MHz, BCLK=1.024MHz, LRCK=16KHz, 2 channel, 32bit Slot width, 24bit Sample resolution.

2-ADC 16KHz Record setup sequence:

```
Reg[0x00] = 0x12; //reset to default status
Reg[0x01] = 0x80; //verf enable, verf fast startup enable
Reg[0x02] = 0x55; //MICBIAS enable
Reg[0x21] = 0x07; //Module clock enable<I2S, ADC digital, ADC analog>
Reg[0x22] = 0x03; //Module reset de-asserted<I2S, ADC digital>
Reg[0xA4] = 0x40; //enable ADC1 analog part
Reg[0xA9] = 0x40; //enable ADC2 analog part
Reg[0x20] = 0x01; //system clock enable
Reg[0x30] = 0x15; //I2S TX enable & I2S slave
Reg[0x33] = 0x1F; //set LRCK_PERIODL=32*BCLK width
Reg[0x34] = 0x15; //set I2S format: I2S Justified mode
Reg[0x35] = 0x75; //set Slot width=32-bit, Sample resolution=24-bit
Reg[0x38] = 0x01; //set I2S TX Channel (slot) number: 2
Reg[0x39] = 0x03; //I2S TX Channel 1 ~ Channel 2 (slot) enable
Reg[0x3C] = 0x02; //I2S TX mapping
Reg[0x60] = 0x03; //set ADC Sample Rate: 16KHz
Reg[0x61] = 0x07; //enable ADC digital part
Reg[0x66] = 0x03; //enable HPF
Reg[0xA2] = 0x19; //ADC1 Analog PGA Gain: 24dB
Reg[0xA7] = 0x19; //ADC2 Analog PGA Gain: 24dB
Reg[0x01] = 0xA0; //verf enable, verf fast startup disable
```

7.5 Register Maps

Register Name	Offset	Description
CHIP_AUDIO_RST	0x00	Soft Reset Register
PWR_CTRL1	0x01	Power Control 1 Register
PWR_CTRL2	0x02	Power Control 2 Register
PLL_CTRL1	0x10	PLL Configure Control 1 Register
PLL_CTRL2	0x11	PLL Configure Control 2 Register
PLL_CTRL3	0x12	PLL Configure Control 3 Register
PLL_CTRL4	0x13	PLL Configure Control 4 Register
PLL_CTRL5	0x14	PLL Configure Control 5 Register
PLL_CTRL6	0x16	PLL Configure Control 6 Register
PLL_CTRL7	0x17	PLL Configure Control 7 Register
PLL_LOCK_CTRL	0x18	PLL Configure Control 8 Register
SYSCLK_CTRL	0x20	System Clock Control Register
MOD_CLK_EN	0x21	Module Clock Enable Control Register
MOD_RST_CTRL	0x22	Module Reset Control Register
I2S_CTRL	0x30	I2S Control Register
I2S_BCLK_CTRL	0x31	I2S BCLK Configure Register
I2S_LRCK_CTRL1	0x32	I2S LRCK Configure 1 Register
I2S_LRCK_CTRL2	0x33	I2S LRCK Configure 2 Register
I2S_FMT_CTRL1	0x34	I2S Format Configure 1 Register
I2S_FMT_CTRL2	0x35	I2S Format Configure 2 Register
I2S_FMT_CTRL3	0x36	I2S Format Configure 3 Register
I2S_TX_CTRL1	0x38	I2S TX Control 1 Register
I2S_TX_CTRL2	0x39	I2S TX Control 2 Register
I2S_TX_CTRL3	0x3A	I2S TX Control 3 Register
I2S_TX_CHMP_CTRL1	0x3C	I2S TX Channel Mapping Control 1 Register
I2S_TX_CHMP_CTRL2	0x3D	I2S TX Channel Mapping Control 2 Register
I2S_RX_CTRL1	0x50	I2S RX Control 1 Register
I2S_RX_CTRL2	0x51	I2S RX Control 2 Register
I2S_RX_CTRL3	0x52	I2S RX Control 3 Register
I2S_RX_CHMP_CTRL1	0x54	I2S RX Channel Mapping Control 1 Register
I2S_RX_CHMP_CTRL2	0x55	I2S RX Channel Mapping Control 2 Register
PDM_CTRL	0x59	PDM Control Register
ADC_SPRC	0x60	ADC Sample Rate Select Register
ADC_DIG_EN	0x61	ADC Digital Part Enable Register
HPF_EN	0x66	Digital HPF Enable Register
ADC1_DVOL_CTRL	0x70	ADC1 Digital Channel Volume Control Register
ADC2_DVOL_CTRL	0x71	ADC2 Digital Channel Volume Control Register
ADC1_DMIX_SRC	0x76	ADC1 Digital Mixer Source Control Register
ADC2_DMIX_SRC	0x77	ADC2 Digital Mixer Source Control Register
ADC_DIG_DEBUG	0x7F	ADC Digital Debug Control Register

ADC_ANA_DEBUG2	0x81	ADC Analog Debug Control 2 Register
I2S_PADDRV_CTRL	0x82	I2S Pad Drive Control Register
DIG_ADC_CTRL	0x83	ADC Digital Control Register
ANA_ADC1_CTRL1	0xA0	ADC1 Analog Control 1 Register
ANA_ADC1_CTRL2	0xA1	ADC1 Analog Control 2 Register
ANA_ADC1_CTRL3	0xA2	ADC1 Analog Control 3 Register
ANA_ADC1_CTRL4	0xA3	ADC1 Analog Control 4 Register
ANA_ADC1_CTRL5	0xA4	ADC1 Analog Control 5 Register
ANA_ADC2_CTRL1	0xA5	ADC2 Analog Control 1 Register
ANA_ADC2_CTRL2	0xA6	ADC2 Analog Control 2 Register
ANA_ADC2_CTRL3	0xA7	ADC2 Analog Control 3 Register
ANA_ADC2_CTRL4	0xA8	ADC2 Analog Control 4 Register
ANA_ADC2_CTRL5	0xA9	ADC2 Analog Control 5 Register
ADC_DITHER_CTRL	0xAA	ADC Dither Control Register

Reg 00h_Chip Soft Reset Register

Default: 0x4B			Register Name: CHIP_AUDIO_RST
Bit	Read/Write	Default	Description
7:0	R/W	0x4B	Reading this register will indicate device type and version. Writing this register 0x12 resets all register to their default state.

Reg 01h_Power Control 1 Register

Default: 0x00			Register Name: PWR_CTRL1
Bit	Read/Write	Default	Description
7	R/W	0	VREF_ENABLE VREF Enable 0 = Disable 1 = Enable
6	R/W	0	VREF_LPMODE VREF Low Power Mode Control 0: Normal 1: Low Power
5	R/W	0	VREF_FSU_DISABLE VREF Fast Start Up Disable 0: Enable 1: Disable
4:3	R/W	0	VREF_RESCTRL VREF Output Resistor Control 00: 1M Ohm 01: 2.2k Ohm 10: 10M Ohm 11: 100k Ohm

2:0	R/W	0	IGEN_TRIM Tune bias current generator for all audio input channels 000=Nominal (5uA) 001=-4.8% 010=-9.1% 011=-13% 100=+25% 101=+17.6% 110=+11% 111=+5.2%
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Reg 02h_Power Control 2 Register

Default: 0x11			Register Name: PWR_CTRL2
Bit	Read/Write	Default	Description
7	R/W	0	VREF_SEL VREF Source Selection 0: From BandGap 1: From AVCC
6	R/W	0	MICBIAS2_EN MICBIAS2 Enable 0: Disable 1: Enable
5:4	R/W	1	MICBIAS2_VCTRL MICBIAS2 Voltage Control 00: 1.8V 01: 2.1V 10: 2.4V 11: 3V
3	/	/	/
2	R/W	0	MICBIAS1_EN MICBIAS1 Enable 0: Disable 1: Enable
1:0	R/W	1	MICBIAS1_VCTRL MICBIAS1 Voltage Control 00: 1.8V 01: 2.1V 10: 2.4V 11: 3V

Reg 10h_PLL Configure Control 1 Register

Default: 0x48			Register Name: PLL_CTRL1
Bit	Read/Write	Default	Description
7	/	/	/

6:4	R/W	0x4	PLL_IBIAS PLL internal bias current tuning 0: min ... 7: max
3	R/W	0x1	PLL_NDET PLL loop divider factor detection 0: Disable 1: Enable
2	R	0x0	PLL Locked status 0: Not locked or not enabled 1: Enabled and locked
1	R/W	0x0	PLL_COM_EN PLL Common voltage Enable 0: Disable 1: Enable
0	R/W	0x0	PLL_EN PLL Enable 0: Disable 1: Enable The PLL output $F_{OUT} = F_{IN} \cdot N / ((M1+1) \cdot (M2+1) \cdot (K1+1) \cdot (K2+1))$;

Reg 11h_PLL Configure Control 2 Register

Default: 0x00			Register Name: PLL_CTRL2
Bit	Read/Write	Default	Description
7:6	/	/	/
5	R/W	0x0	PLL_PREDIV2 PLL pre-divider factor M2 Factor=0, M2=0 Factor=1, M2=1
4:0	R/W	0x0	PLL_PREDIV1 PLL pre-divider factor M1 Factor=0, M1=0 Factor=1, M1=1 ... Factor=31, M1=31

Reg 12h_PLL Configure Control 3 Register

Default: 0x03			Register Name: PLL_CTRL3
Bit	Read/Write	Default	Description
7:2	/	/	/
1:0	R/W	0x3	PLL_LOOPDIV_MSB The 2-High Bit of PLL Loop Divider Factor N. Factor=0, N=0 Factor=1, N=1

			... Factor=1023, N=1023 Factor N is equal to [PLL_LOOPDIV_MSB, PLL_LOOPDIV_LSB]
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Reg 13h_PLL Configure Control 4 Register

Default: 0x0D			Register Name: PLL_CTRL4
Bit	Read/Write	Default	Description
7:0	R/W	0x0D	PLL_LOOPDIV_LSB The 8-Low Bit of PLL PLL Loop Divider Factor N. Factor=0, N=0 Factor=1, N=1 ... Factor=1023, N=1023 Factor N is equal to [PLL_LOOPDIV_MSB, PLL_LOOPDIV_LSB]

Reg 14h_PLL Configure Control 5 Register

Default: 0x00			Register Name: PLL_CTRL5
Bit	Read/Write	Default	Description
7:6	/	/	/
5	R/W	0x0	PLL_POSTDIV2 PLL post-divider factor K2 Factor=0, K2=0 Factor=1, K2=1
4:0	R/W	0x0	PLL_POSTDIV1 PLL post-divider factor K1 Factor=0, K1=0 Factor=1, K1=1 ... Factor=31, K1=31

Reg 16h_PLL Configure Control 6 Register

Default: 0x0F			Register Name: PLL_CTRL6
Bit	Read/Write	Default	Description
7:6	R/W	0x0	PLL_LDO PLL internal ldo voltage tuning 00: 1.8V 01: 2.0V 10: 2.2V 11: 2.4V
5	/	/	/
4:0	R/W	0xF	PLL_CP PLL pll cp current tuning 0: min ...

			31: max
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Reg 17h_PLL Configure Control 7 Register

Default: 0xD0			Register Name: PLL_CTRL7
Bit	Read/Write	Default	Description
7:6	R/W	0x3	PLL_CAP PLL loop filter capacitance tuning 0: min ... 3: max
5:4	R/W	0x1	PLL_RES PLL loop filter resistance tuning 0: min ... 3: max
3:0	/	/	/

Reg 18h_PLL Configure Control 8 Register

Default: 0x00			Register Name: PLL_LOCK_CTRL
Bit	Read/Write	Default	Description
7	/	/	/
6:4	R/W	0x0	HOLD_TIME SYSCLK hold time T T=0, Bypass T=1, 1 LRCK width ... T=7, 7 LRCK width
3:2	R/W	0x0	LOCK_LEVEL1 PLL lock level1 00: 21-29 clock cycles 01: 22-28 clock cycles 1x: 20-30 clock cycles
1	R/W	0x0	LOCK_LEVEL2 PLL lock level2 0: 24-26 clock cycles 1: 23-27 clock cycles
0	R/W	0x0	PLL_LOCK_EN PLL clk lock enable 0: disable 1: enable

Reg 20h_System Clock Control Register

Default: 0x00	Register Name: SYSCLK_CTRL
---------------	----------------------------

Bit	Read/Write	Default	Description
7	R/W	0x0	PLLCLK_EN PLLCLK Enable 0: Disable 1: Enable
6	/	/	/
5:4	R/W	0x0	PLLCLK_SRC PLL Clock Source Select 0: MCLK 1: BCLK 2: PDMCLK 3: Reserved
3:2	R/W	0x0	SYSCCLK_SRC System Clock Source Select 0: MCLK 1: BCLK 2: PLL 3: Reserved
1	/	/	/
0	R/W	0x0	SYSCCLK_EN SYSCCLK Enable 0: Disable 1: Enable

Reg 21h_Module Clock Enable Control Register

Default: 0x00			Register Name: MOD_CLK_EN
Bit	Read/Write	Default	Description
7:3	/	/	/
2:0	R/W	0x0	Module clock enable control 0-Clock disable 1-Clock enable BIT2- ADC analog BIT1- ADC digital BIT0- I2S

Reg 22h_Module Reset Control Register

Default: 0x00			Register Name: MOD_RST_CTRL
Bit	Read/Write	Default	Description
7:5	/	/	/
4	R/W	0x0	Connect Globe Enable to I2S reset control 0: Enable 1: Disable
3:2	/	/	/
1:0	R/W	0x0	Module reset control 0-Reset asserted

			1-Reset de-asserted BIT1- ADC digital BIT0- I2S
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Reg 30h_I2S Control Register

Default: 0x00			Register Name: I2S_CTRL
Bit	Read/Write	Default	Description
7	R/W	0x0	BCLK_IOEN 0: Input 1: Output
6	R/W	0x0	LRCK_IOEN 0: Input 1: Output
5	R/W	0x0	MCLK_IOEN 0: Input 1: Output PLL_test
4	R/W	0x0	SDO_EN 0: Disable, Hi-Z state 1: Enable
3	/	/	/
2	R/W	0x0	TXEN Transmitter Block Enable 0: Disable 1: Enable
1	R/W	0x0	RXEN Receiver Block Enable 0: Disable 1: Enable
0	R/W	0x0	GEN Globe Enable A disable on this bit overrides any other block or channel enables. 0: Disable 1: Enable

Reg 31h_I2S BCLK Configure Register

Default: 0x00			Register Name: I2S_BCLK_CTRL
Bit	Read/Write	Default	Description
7:6	/	/	/
5	R/W	0x0	EDGE_TRANSFER 0: SDO drive data and SDI sample data at the different BCLK edge 1: SDO drive data and SDI sample data at the same BCLK edge
4	R/W	0x0	BCLK_POLARITY 0: normal mode, negative edge drive 1: invert mode, positive edge drive
3:0	R/W	0x0	BCLKDIV

			<p>BCLK Divide Ratio from SYSCLK</p> <p>0: reserved</p> <p>1: Divide by 1</p> <p>2: Divide by 2</p> <p>3: Divide by 4</p> <p>4: Divide by 6</p> <p>5: Divide by 8</p> <p>6: Divide by 12</p> <p>7: Divide by 16</p> <p>8: Divide by 24</p> <p>9: Divide by 32</p> <p>10: Divide by 48</p> <p>11: Divide by 64</p> <p>12: Divide by 96</p> <p>13: Divide by 128</p> <p>14: Divide by 176</p> <p>15: Divide by 192</p> <p>This bit is only used in master mode</p>
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Reg 32h_I2S LRCK Configure 1 Register

Default: 0x00			Register Name: I2S_LRCK_CTRL1
Bit	Read/Write	Default	Description
7:5	/	/	/
4	R/W	0x0	<p>LRCK_POLARITY</p> <p>When apply in I2S / Left-Justified / Right-Justified mode:</p> <p>0: Left channel when LRCK is low</p> <p>1: Left channel when LRCK is high</p> <p>When apply in PCM mode:</p> <p>0: PCM LRCK asserted at the negative edge</p> <p>1: PCM LRCK asserted at the positive edge</p>
3:2	/	/	/
1:0	R/W	0x0	<p>LRCK_PERIODH</p> <p>The 2-High bit of LRCK period value. It is used to program the number of BCLKs per channel of sample frame. This value is interpreted as follow:</p> <p>PCM mode: Number of BCLKs within (Left + Right) channel width</p> <p>I2S / Left-Justified / Right-Justified mode: Number of BCLKs within each individual channel width (Left or Right)</p> <p>N+1</p> <p>For example:</p> <p>n = 7: 8 BCLKs width</p> <p>...</p> <p>n = 1023: 1024 BCLKs width</p> <p>This bit is must be configured in master or slave mode</p>

Reg 33h_I2S LRCK Configure 2 Register

Default: 0x00			Register Name: I2S_LRCK_CTRL2
Bit	Read/Write	Default	Description
7:0	R/W	0x0	<p>LRCK_PERIODL</p> <p>The 8-Low bit of LRCK period value. It is used to program the number of BCLKs per channel of sample frame. This value is interpreted as follow:</p> <p>PCM mode: Number of BCLKs within (Left + Right) channel width</p> <p>I2S / Left-Justified / Right-Justified mode: Number of BCLKs within each individual channel width (Left or Right)</p> <p>N+1</p> <p>For example:</p> <p>n = 7: 8 BCLKs width</p> <p>...</p> <p>n = 1023: 1024 BCLKs width</p> <p>This bit is must be configured in master or slave mode</p>

Reg 34h_I2S Format Configure 1 Register

Default: 0x00			Register Name: I2S_FMT_CTRL1
Bit	Read/Write	Default	Description
7	R/W	0x0	<p>ENCD_FMT</p> <p>Encoding Mode coding format Selection</p> <p>0: 0,1,...,N-1</p> <p>1: 1,2,...,N</p> <p>N is the channel (slot) number</p>
6	R/W	0x0	<p>ENCD_SEL</p> <p>Encoding Mode Selection</p> <p>0: disable</p> <p>1: enable</p>
5:4	R/W	0x0	<p>MODE_SEL</p> <p>Mode Selection</p> <p>0: PCM mode (offset 0: PCM_B; offset 1: PCM_A)</p> <p>1: Left-Justified mode (offset 0: LJ mode; offset 1: I2S mode)</p> <p>2: Right-Justified mode</p> <p>3: Reserved</p>
3	/	/	/
2	R/W	0x0	<p>TX_OFFSET</p> <p>TX offset tune, TX data offset to LRCK</p> <p>0: no offset</p> <p>1: data is offset by 1 BCLKs to LRCK</p>
1	R/W	0x0	<p>TX_SLOT_HI_Z</p> <p>0: normal mode for the last half cycle of BCLK in the slot</p> <p>1: turn to hi-z state for the last half cycle of BCLK in the slot</p>
0	R/W	0x0	<p>TX_STATE</p> <p>0: transfer level 0 when not transferring slot</p>

1: turn to hi-z state (TDM) when not transferring slot

Reg 35h_I2S Format Configure 2 Register

Default: 0x55			Register Name: I2S_FMT_CTRL2
Bit	Read/Write	Default	Description
7	/	/	/
6:4	R/W	0x5	SW Slot Width Select 0: Reserved 1: Reserved 2: Reserved 3: 16-bit 4: 20-bit 5: 24-bit 6: 28-bit 7: 32-bit
3	/	/	/
2:0	R/W	0x5	SR Sample Resolution 0: Reserved 1: Reserved 2: Reserved 3: 16-bit 4: 20-bit 5: 24-bit 6: 28-bit 7: 32-bit

Reg 36h_I2S Format Configure 3 Register

Default: 0x60			Register Name: I2S_FMT_CTRL3
Bit	Read/Write	Default	Description
7	R/W	0x0	TX MLS MSB / LSB First Select 0: MSB First 1: LSB First
6:5	R/W	0x3	SEXT Sign Extend in slot [sample resolution < slot width] 0: Zeros or audio gain padding at LSB position 1: Sign extension at MSB position 2: Reserved 3: Transfer 0 after each sample in each slot
4	/	/	/
3	R/W	0x0	SDOUT Mute 0: normal transfer 1: force DOUT to output 0

2	R/W	0x0	LRCK_WIDTH LRCK width 0: LRCK = 1 BCLK width (short frame) 1: LRCK = 2 BCLK width (long frame) (this bit is only used in PCM mode)
1:0	R/W	0x0	TX_PDM PCM Data Mode 0: Linear PCM 1: reserved 2: 8-bits u-law 3: 8-bits A-law (this bit is only used in PCM mode)

Reg 38h_I2S TX Control 1 Register

Default: 0x00			Register Name: I2S_TX_CTRL1
Bit	Read/Write	Default	Description
7:4	/	/	/
3:0	R/W	0x0	TX_CHSEL TX Channel (slot) number Select for each output 0: 1 channel (slot) ... 7: 8 channels (slots) 8: 9 channels (slots) ... 15: 16 channels (slots)

Reg 39h_I2S TX Control 2 Register

Default: 0x00			Register Name: I2S_TX_CTRL2
Bit	Read/Write	Default	Description
7:0	R/W	0x0	TX_CHEN_LOW TX Channel1 ~Channel8 (slot) enable, bit[7:0] refer to slot [8:1]. When one or more slot(s) is(are) disabled, the affected slot(s) is(are) set to disable state 0: disable 1: enable

Reg 3Ah_I2S TX Control 3 Register

Default: 0x00			Register Name: I2S_TX_CTRL3
Bit	Read/Write	Default	Description
7:0	R/W	0x0	TX_CHEN_HIGH TX Channel9 ~Channel16(slot) enable, bit[7:0] refer to slot [16:9]. When one or more slot(s) is(are) disabled, the affected slot(s) is(are) set to disable state 0: disable 1: enable

Reg 3Ch_I2S TX Channel Mapping Control 1 Register

Default: 0x00			Register Name: I2S_TX_CHMP_CTRL1
Bit	Read/Write	Default	Description
7	R/W	0x0	TX_CH8_MAP TX Channel8 Mapping 0: 1st adc sample 1: 2th adc sample
6	R/W	0x0	TX_CH7_MAP TX Channel7 Mapping 0: 1st adc sample 1: 2th adc sample
5	R/W	0x0	TX_CH6_MAP TX Channel6 Mapping 0: 1st adc sample 1: 2th adc sample
4	R/W	0x0	TX_CH5_MAP TX Channel5 Mapping 0: 1st adc sample 1: 2th adc sample
3	R/W	0x0	TX_CH4_MAP TX Channel4 Mapping 0: 1st adc sample 1: 2th adc sample
2	R/W	0x0	TX_CH3_MAP TX Channel3 Mapping 0: 1st adc sample 1: 2th adc sample
1	R/W	0x0	TX_CH2_MAP TX Channel2 Mapping 0: 1st adc sample 1: 2th adc sample
0	R/W	0x0	TX_CH1_MAP TX Channel1 Mapping 0: 1st adc sample 1: 2th adc sample

Reg 3Dh_I2S TX Channel Mapping Control 2 Register

Default: 0x00			Register Name: I2S_TX_CHMP_CTRL2
Bit	Read/Write	Default	Description
7	R/W	0x0	TX_CH16_MAP TX Channel16 Mapping 0: 1st adc sample 1: 2th adc sample
6	R/W	0x0	TX_CH15_MAP

			TX Channel15 Mapping 0: 1st adc sample 1: 2th adc sample
5	R/W	0x0	TX_CH14_MAP TX Channel14 Mapping 0: 1st adc sample 1: 2th adc sample
4	R/W	0x0	TX_CH13_MAP TX Channel13 Mapping 0: 1st adc sample 1: 2th adc sample
3	R/W	0x0	TX_CH12_MAP TX Channel12 Mapping 0: 1st adc sample 1: 2th adc sample
2	R/W	0x0	TX_CH11_MAP TX Channel11 Mapping 0: 1st adc sample 1: 2th adc sample
1	R/W	0x0	TX_CH10_MAP TX Channel10 Mapping 0: 1st adc sample 1: 2th adc sample
0	R/W	0x0	TX_CH9_MAP TX Channel9 Mapping 0: 1st adc sample 1: 2th adc sample

Reg 50h_I2S RX Control 1 Register

Default: 0x00			Register Name: I2S_RX_CTRL1
Bit	Read/Write	Default	Description
7:4	/	/	/
3:0	R/W	0x0	RX_CHSEL RX Channel (slot) number Select for each input 0: 1 channel (slot) ... 7: 8 channels (slots) 8: 9 channels (slots) ... 15: 16 channels (slots)

Reg 51h_I2S RX Control 2 Register

Default: 0x03			Register Name: I2S_RX_CTRL2
Bit	Read/Write	Default	Description
7:0	R/W	0x3	RX_CHEN_LOW

			RX Channel1 ~Channel8 (slot) enable, bit[7:0] refer to slot [8:1]. When one or more slot(s) is(are) disabled, the affected slot(s) is(are) set to disable state 0: disable 1: enable
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Reg 52h_I2S RX Control 3 Register

Default: 0x00			Register Name: I2S_RX_CTRL3
Bit	Read/Write	Default	Description
7:0	R/W	0x0	RX_CHEN_HIGH RX Channel9 ~Channel16(slot) enable, bit[7:0] refer to slot [16:9]. When one or more slot(s) is(are) disabled, the affected slot(s) is(are) set to disable state 0: disable 1: enable

Reg 54h_I2S RX Channel Mapping Control 1 Register

Default: 0x00			Register Name: I2S_RX_CHMP_CTRL1
Bit	Read/Write	Default	Description
7	R/W	0x0	RX_CH8_MAP RX Channel8 Mapping 0: 1st adc sample 1: 2th adc sample
6	R/W	0x0	RX_CH7_MAP RX Channel7 Mapping 0: 1st adc sample 1: 2th adc sample
5	R/W	0x0	RX_CH6_MAP RX Channel6 Mapping 0: 1st adc sample 1: 2th adc sample
4	R/W	0x0	RX_CH5_MAP RX Channel5 Mapping 0: 1st adc sample 1: 2th adc sample
3	R/W	0x0	RX_CH4_MAP RX Channel4 Mapping 0: 1st adc sample 1: 2th adc sample
2	R/W	0x0	RX_CH3_MAP RX Channel3 Mapping 0: 1st adc sample 1: 2th adc sample
1	R/W	0x0	RX_CH2_MAP RX Channel2 Mapping 0: 1st adc sample 1: 2th adc sample

0	R/W	0x0	RX_CH1_MAP RX Channel1 Mapping 0: 1st adc sample 1: 2th adc sample
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Reg 55h_I2S RX Channel Mapping Control 2 Register

Default: 0x00			Register Name: I2S_RX_CHMP_CTRL2
Bit	Read/Write	Default	Description
7	R/W	0x0	RX_CH16_MAP RX Channel16 Mapping 0: 1st adc sample 1: 2th adc sample
6	R/W	0x0	RX_CH15_MAP RX Channel15 Mapping 0: 1st adc sample 1: 2th adc sample
5	R/W	0x0	RX_CH14_MAP RX Channel14 Mapping 0: 1st adc sample 1: 2th adc sample
4	R/W	0x0	RX_CH13_MAP RX Channel13 Mapping 0: 1st adc sample 1: 2th adc sample
3	R/W	0x0	RX_CH12_MAP RX Channel12 Mapping 0: 1st adc sample 1: 2th adc sample
2	R/W	0x0	RX_CH11_MAP RX Channel11 Mapping 0: 1st adc sample 1: 2th adc sample
1	R/W	0x0	RX_CH10_MAP RX Channel10 Mapping 0: 1st adc sample 1: 2th adc sample
0	R/W	0x0	RX_CH9_MAP RX Channel9 Mapping 0: 1st adc sample 1: 2th adc sample

Reg 59h_PDM Control Register

Default: 0x00			Register Name: PDM_CTRL
Bit	Read/Write	Default	Description
7:2	/	/	/

1	R/W	0x0	PDM_TIMING PDM timing control 0: Latch ADC1 data on rising clock edge. Latch ADC2 data on falling clock edge. 1: Latch ADC1 data on falling clock edge. Latch ADC2 data on rising clock edge.
0	R/W	0x0	PDM_EN PDM interface Enable 0: Disable 1: Enable When PDM_EN = 1, LRCK is used for PDMCLK input and SDOUT is used for PDMDATA output.

Reg 60h_ADC Sample Rate Select Register

Default: 0x00			Register Name: ADC_SPRC
Bit	Read/Write	Default	Description
7:4	/	/	/
3:0	R/W	0x0	ADC_FS_I2S ADC Sample Rate synchronized with I2S clock zone 0000: 8KHz 0001: 11.025KHz 0010: 12KHz 0011: 16KHz 0100: 22.05KHz 0101: 24KHz 0110: 32KHz 0111: 44.1KHz 1000: 48KHz Other: Reserved

Reg 61h_ADC Digital Part Enable Register

Default: 0x00			Register Name: ADC_DIG_EN
Bit	Read/Write	Default	Description
7:4	R/W	0x0	REQ_WIDTH 0:min ... 15:max
3	R/W	0x0	REQ_EN 0: Disable 1: Enable
2	R/W	0x0	DG_EN ADC Digital part globe enable 0: Disable 1: Enable
1	R/W	0x0	ENAD2

			ADC2 digital part enable 0: Disable 1: Enable
0	R/W	0x0	ENAD1 ADC1 digital part enable 0: Disable 1: Enable

Reg 66h_Digital HPF Enable Register

Default: 0x03			Register Name: HPF_EN
Bit	Read/Write	Default	Description
7:2	/	/	/
1	R/W	0x1	DIG_ADC2_HP_F_EN Digital ADC2 channel HPF enable 0: Disable 1: Enable
0	R/W	0x1	DIG_ADC1_HP_F_EN Digital ADC1 channel HPF enable 0: Disable 1: Enable

Reg 70h_ADC1 Digital Channel Volume Control Register

Default: 0xA0			Register Name: ADC1_DVOL_CTRL
Bit	Read/Write	Default	Description
7:0	R/W	0xA0	DIG_ADCL1_VOL ADC1 Digital channel volume Control (-119.25dB To 71.25dB, 0.75dB/Step) 0x00: Mute 0x01: -119.25dB 0x9F = -0.75dB 0xA0 = 0dB 0xA1 = 0.75dB 0xFF = 71.25dB

Reg 71h_ADC2 Digital Channel Volume Control Register

Default: 0xA0			Register Name: ADC2_DVOL_CTRL
Bit	Read/Write	Default	Description
7:0	R/W	0xA0	DIG_ADCL2_VOL ADC2 Digital channel volume Control (-119.25dB To 71.25dB, 0.75dB/Step) 0x00: Mute 0x01: -119.25dB

			<p>.....</p> <p>0x9F = -0.75dB</p> <p>0xA0 = 0dB</p> <p>0xA1 = 0.75dB</p> <p>.....</p> <p>0xFF = 71.25dB</p>
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Reg 76h_ADC1 Digital Mixer Source Control Register

Default: 0x01			Register Name: ADC1_DMIX_SRC
Bit	Read/Write	Default	Description
7:4	/	/	/
3:2	R/W	0x0	<p>ADC1_DMIXL_GC</p> <p>ADC1 channel digital mixer gain control</p> <p>0: 0dB 1: -6dB</p> <p>Bit3: ADC2 data</p> <p>Bit2: ADC1 data</p>
1:0	R/W	0x1	<p>ADC1_DMIXL_SRC</p> <p>ADC1 channel digital mixer source select</p> <p>0: Disable 1: Enable</p> <p>Bit1: ADC2 data</p> <p>Bit0: ADC1 data</p>

Reg 77h_ADC2 Digital Mixer Source Control Register

Default: 0x02			Register Name: ADC2_DMIX_SRC
Bit	Read/Write	Default	Description
7:4	/	/	/
3:2	R/W	0x0	<p>ADC2_DMIXL_GC</p> <p>ADC2 channel digital mixer gain control</p> <p>0: 0dB 1: -6dB</p> <p>Bit3: ADC2 data</p> <p>Bit2: ADC1 data</p>
1:0	R/W	0x2	<p>ADC2_DMIXL_SRC</p> <p>ADC2 channel digital mixer source select</p> <p>0: Disable 1: Enable</p> <p>Bit1: ADC2 data</p> <p>Bit0: ADC1 data</p>

Reg 7Fh_ADC Digital Debug Control Register

Default: 0x00			Register Name: ADC_DIG_DEBUG
Bit	Read/Write	Default	Description
7:4	/	/	/
3	R/W	0x0	<p>I2S_LPB_DEBUG</p> <p>RX-> TXdata loopback</p> <p>0: disable</p>

			1: enable
2:0	R/W	0x0	ADC_PTN_SEL ADC Pattern Select 000: Normal 001: 0x5A5A5A(24-bit) 010: 0x123456 (24-bit) 011: zero data 1xx: I2S_RX data When this bit selected, the digital path data source will be changed to internal rom data

Reg 81h_ADC Analog Debug Control 2 Register

Default: 0x11			Register Name: ADC_ANA_DEBUG2
Bit	Read/Write	Default	Description
7	/	/	/
6:4	R/W	0x1	Pad Select for DEV_ID1 PIN. 000: IO Disable 001: DEV_ID1 other: Reserved
3	/	/	/
2:0	R/W	0x1	Pad Select for DEV_ID0 PIN. 000: IO Disable 001: DEV_ID0 other: Reserved

Reg 82h_I2S Pad Drive Control Register

Default: 0x55			Register Name: I2S_PADDRV_CTRL
Bit	Read/Write	Default	Description
7:6	R/W	0x1	Pad programmable drive control for MCLK. 00: Level 0 01: Level 1 10: Level 2 11: Level 3
5:4	R/W	0x1	Pad programmable drive control for BCLK. 00: Level 0 01: Level 1 10: Level 2 11: Level 3
3:2	R/W	0x1	Pad programmable drive control for LRCK. 00: Level 0 01: Level 1 10: Level 2 11: Level 3
1:0	R/W	0x1	Pad programmable drive control for SDOUT. 00: Level 0 01: Level 1 10: Level 2 11: Level 3

Reg A0h_ADC1 Analog Control 1 Register

Default: 0x00			Register Name: ANA_ADC1_CTRL1
Bit	R/W	Default	Description

7:5	R/W	0x0	RX1_PGA_OI_CTRL Channel 1 PGA Output Current Driver Strength Control 0 = 30I 4 = 50I 1 = 25I 5 = 45I 2 = 40I 6 = 60I 3 = 35I 7 = 55I I = Bias current of OTA, default = 5uA
4:2	R/W	0x0	RX1_PGA_AMP_IB_SEL Channel 1 PGA Bias Current Control 0 = 5 uA 4 = 3 uA 1 = 5.5 uA 5 = 3.5 uA 2 = 6 uA 6 = 4 uA 3 = 6.5 uA 7 = 4.5 uA
1:0	R/W	0x0	RX1_PGA_IN_VCM_CTRL Channel 1 PGA High-gain Common-Mode Voltage Control 0 = 1.65V 1 = 1.45V 2 = 1.39V 3 = 1.29V when PGA work on low-gain(0/-6dB), the Common-Mode Voltage is fixed 1.65V.

Reg A1h_ADC1 Analog Control 2 Register

Default:0x00			Register Name: ANA_ADC1_CTRL2
Bit	R/W	Default	Description
7:6	/	/	/
5:3	R/W	0x0	RX1_PGA_OI_NM_CTRL Channel 1 PGA High Gain Output Current Driver Strength Control 0 = 21 I 4 = 33 I 1 = 24 I 5 = 36 I 2 = 15 I 6 = 27 I 3 = 18 I 7 = 30 I I = Bias current of OTA, default = 5uA
2:0	R/W	0x0	RX1_PGA_NMAMP_IB_SEL Channel 1 PGA High Gain Bias Current Control 0 = 5 uA 4 = 3 uA 1 = 5.5 uA 5 = 3.5 uA 2 = 6 uA 6 = 4 uA 3 = 6.5 uA 7 = 4.5 uA

Reg A2h_ADC1 Analog Control 3 Register

Default:0x00			Register Name: ANA_ADC1_CTRL3
Bit	R/W	Default	Description
7	/	/	/
6:5	R/W	0x0	RX1_PGA_CTRL_RCM Channel 1 high-gain PGA input impedance control

			0 = 100 k Ω 1 = 75 k Ω 2 = 50 k Ω 3 = 25 k Ω when PGA work on 0dB/-6dB, the input impedance is 8K/16K.
4:0	R/W	0x0	RX1_PGA_GAIN_CTRL Channel 1 PGA gain settings: 0 = -6 dB 16 = 15 dB 1 = 0 dB 17 = 16 dB 2 = 0 dB 18 = 17 dB 3 = 0 dB 19 = 18 dB 4 = 3 dB 20 = 19 dB 5 = 4 dB 21 = 20 dB 6 = 5 dB 22 = 21 dB 7 = 6 dB 23 = 22 dB 8 = 7 dB 24 = 23 dB 9 = 8 dB 25 = 24 dB 10 = 9 dB 26 = 25 dB 11 = 10 dB 27 = 26 dB 12 = 11 dB 28 = 27 dB 13 = 12 dB 29 = 28 dB 14 = 13 dB 30 = 29 dB 15 = 14 dB 31 = 30 dB

Reg A3h_ADC1 Analog Control 4 Register

Default:0x00			Register Name: ANA_ADC1_CTRL4
Bit	R/W	Default	Description
7:5	R/W	0x0	RX1_DSM_OTA_IB_SEL Channel 1 DSM Integrator Bias Current Control 0 = 6 μ A 4 = 4 μ A 1 = 6.5 μ A 5 = 4.5 μ A 2 = 7 μ A 6 = 5 μ A 3 = 7.5 μ A 7 = 5.5 μ A
4:2	R/W	0x0	RX1_DSM_COMP_IB_SEL Channel 1 DSM Comparator Bias Current Control 0 = 6 μ A 4 = 4 μ A 1 = 6.5 μ A 5 = 4.5 μ A 2 = 7 μ A 6 = 5 μ A 3 = 7.5 μ A 7 = 5.5 μ A
1:0	R/W	0x0	RX1_DSM_OTA_CTRL Channel 1 DSM Integrator Driver Strength Control 0 = 100% enabled 1 = 80% enabled 2 = 60% enabled 3 = 40% enabled

Reg A4h_ADC1 Analog Control 5 Register

Default:0x00			Register Name: ANA_ADC1_CTRL5
Bit	R/W	Default	Description
7	/	/	/
6	R/W	0x0	RX1_GLOBAL_EN Channel 1 Global Enable 0 = Disable 1 = Enable
5	R/W	0x0	RX1_DSM_DISABLE Channel 1 DSM Disable 0 = Enable 1 = Disable
4	R/W	0x0	RX1_DSM_DEMOFF Channel 1 DSM DEM Control 0 = Enable DEM 1 = Disable DEM
3	R/W	0x0	RX1_SEL_OUT_EDGE ADC clocking edge Select 0 = DSM output is clocked on falling edge of input clock 1 = DSM output is clocked on rising edge of input clock
2	R/W	0x0	RX1_DSM_VRP_LPMODE Channel 1 VREFP Low Power Mode 0 = Normal 1 = Low Power Mode
1:0	R/W	0x0	RX1_DSM_VRP_OUTCTRL Channel 1 VREFP Output Strength Control 0 = 100% 1 = 75% 2 = 50% 3 = 25%

Reg A5h_ADC2 Analog Control 1 Register

Default:0x00			Register Name: ANA_ADC2_CTRL1
Bit	R/W	Default	Description
7:5	R/W	0x0	RX2_PGA_OI_CTRL Channel 2 PGA Output Current Driver Strength Control 0 = 30I 4 = 50I 1 = 25I 5 = 45I 2 = 40I 6 = 60I 3 = 35I 7 = 55I I = Bias current of OTA, default = 5uA
4:2	R/W	0x0	RX2_PGA_AMP_IB_SEL Channel 2 PGA Bias Current Control 0 = 5 uA 4 = 3 uA

			1 = 5.5 μ A 5 = 3.5 μ A 2 = 6 μ A 6 = 4 μ A 3 = 6.5 μ A 7 = 4.5 μ A
1:0	R/W	0x0	RX2_PGA_IN_VCM_CTRL Channel 2 PGA High-gain Common-Mode Voltage Control 0 = 1.65V 1 = 1.45V 2 = 1.39V 3 = 1.29V when PGA work on low-gain(0/-6dB), the Common-Mode Voltage is fixed 1.65V.

Reg A6h_ADC2 Analog Control 2 Register

Default:0x00			Register Name: ANA_ADC2_CTRL2
Bit	R/W	Default	Description
7:6	/	/	/
5:3	R/W	0x0	RX2_PGA_OI_NM_CTRL Channel 2 PGA High Gain Output Current Driver Strength Control 0 = 21 I 4 = 33 I 1 = 24 I 5 = 36 I 2 = 15 I 6 = 27 I 3 = 18 I 7 = 30 I I = Bias current of OTA, default = 5 μ A
2:0	R/W	0x0	RX2_PGA_NMAMP_IB_SEL Channel 2 PGA High Gain Bias Current Control 0 = 5 μ A 4 = 3 μ A 1 = 5.5 μ A 5 = 3.5 μ A 2 = 6 μ A 6 = 4 μ A 3 = 6.5 μ A 7 = 4.5 μ A

Reg A7h_ADC2 Analog Control 3 Register

Default:0x00			Register Name: ANA_ADC2_CTRL3
Bit	R/W	Default	Description
7	/	/	/
6:5	R/W	0x0	RX2_PGA_CTRL_RCM Channel 2 high-gain PGA input impedance control 0 = 100 k Ω 1 = 75 k Ω 2 = 50 k Ω 3 = 25 k Ω when PGA work on 0dB/-6dB, the input impedance is 8K/16K.
4:0	R/W	0x0	RX2_PGA_GAIN_CTRL Channel 2 PGA gain settings: 0 = -6 dB 16 = 15 dB 1 = 0 dB 17 = 16 dB 2 = 0 dB 18 = 17 dB

		3 = 0 dB 19 = 18 dB
		4 = 3 dB 20 = 19 dB
		5 = 4 dB 21 = 20 dB
		6 = 5 dB 22 = 21 dB
		7 = 6 dB 23 = 22 dB
		8 = 7 dB 24 = 23 dB
		9 = 8 dB 25 = 24 dB
		10 = 9 dB 26 = 25 dB
		11 = 10 dB 27 = 26 dB
		12 = 11 dB 28 = 27 dB
		13 = 12 dB 29 = 28 dB
		14 = 13 dB 30 = 29 dB
		15 = 14 dB 31 = 30 dB

Reg A8h_ADC2 Analog Control 4 Register

Default:0x00			Register Name: ANA_ADC2_CTRL4
Bit	R/W	Default	Description
7:5	R/W	0x0	RX2_DSM_OTA_IB_SEL Channel 2 DSM Integrator Bias Current Control 0 = 6 uA 4 = 4 uA 1 = 6.5 uA 5 = 4.5 uA 2 = 7 uA 6 = 5 uA 3 = 7.5 uA 7 = 5.5 uA
4:2	R/W	0x0	RX2_DSM_COMP_IB_SEL Channel 2 DSM Comparator Bias Current Control 0 = 6 uA 4 = 4 uA 1 = 6.5 uA 5 = 4.5 uA 2 = 7 uA 6 = 5 uA 3 = 7.5 uA 7 = 5.5 uA
1:0	R/W	0x0	RX2_DSM_OTA_CTRL Channel 2 DSM Integrator Driver Strength Control 0 = 100% enabled 1 = 80% enabled 2 = 60% enabled 3 = 40% enabled

Reg A9h_ADC2 Analog Control 5 Register

Default:0x00			Register Name: ANA_ADC2_CTRL5
Bit	R/W	Default	Description
7	/	/	/
6	R/W	0x0	RX2_GLOBAL_EN Channel 2 Global Enable 0 = Disable 1 = Enable
5	R/W	0x0	RX2_DSM_DISABLE

			Channel 2 DSM Disable 0 = Enable 1 = Disable
4	R/W	0x0	RX2_DSM_DEMOFF Channel 2 DSM DEM Control 0 = Enable DEM 1 = Disable DEM
3	R/W	0x0	RX2_SEL_OUT_EDGE Channel 2 ADC clocking edge Select 0 = DSM output is clocked on falling edge of input clock 1 = DSM output is clocked on rising edge of input clock
2	R/W	0x0	RX2_DSM_VRP_LPMODE Channel 2 VREFP Low Power Mode 0 = Normal 1 = Low Power Mode
1:0	R/W	0x0	RX2_DSM_VRP_OUTCTRL Channel 2 VREFP Output Strength Control 0 = 100% 1 = 75% 2 = 50% 3 = 25%

Reg AAh_ADC Dither Control Register

Default:0x00			Register Name: ADC_DITHER_CTRL
Bit	R/W	Default	Description
7:6	/	/	/
5:4	R/W	0x0	DSM_DITHER_CTRL Control of the input pin: dsm_dither_sign and dsm_dither_data 00: single-stage shaped pseudorandom dither signal 01: original pseudorandom dither signal 10: offset voltage of the positive direction 11: offset voltage of the negative direction
3	R/W	0x0	DSM_DITHER_EN Dither Enable 0 = Disable 1 = Enable
2:0	R/W	0x0	DSM_DITHER_LVL Dither level control(Dither level is positive related to the ctrl bits) 000 have no level 1 is the mim level and 7 is the max level

8 Application Information

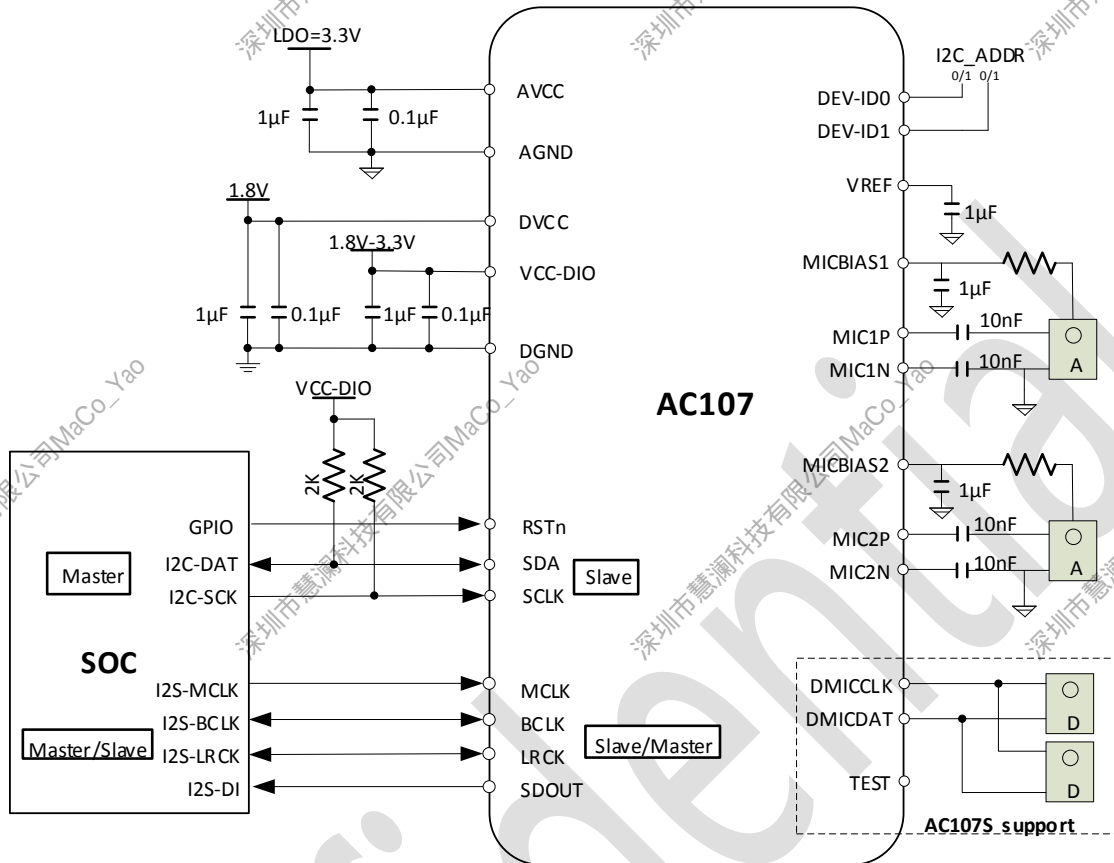


Figure 8-1. Typical Application Diagram

9 PCB Layout Guidelines

Each system design and PCB layout is unique. The layout must be carefully reviewed in the context of a specific PCB design. However, the following guidelines can optimize the AC107 performance:

1. The decoupling capacitors for the power supplies must be placed close to the device terminals. Figure 8-1 shows the recommended decoupling capacitors for the AC107.
2. For analog differential audio signals, they must be routed differentially on the PCB for better noise immunity. Avoid crossing digital and analog signals to avoid undesirable crosstalk.
3. Analog and digital grounds must be separated to prevent possible digital noise from affecting the analog performance of the board.

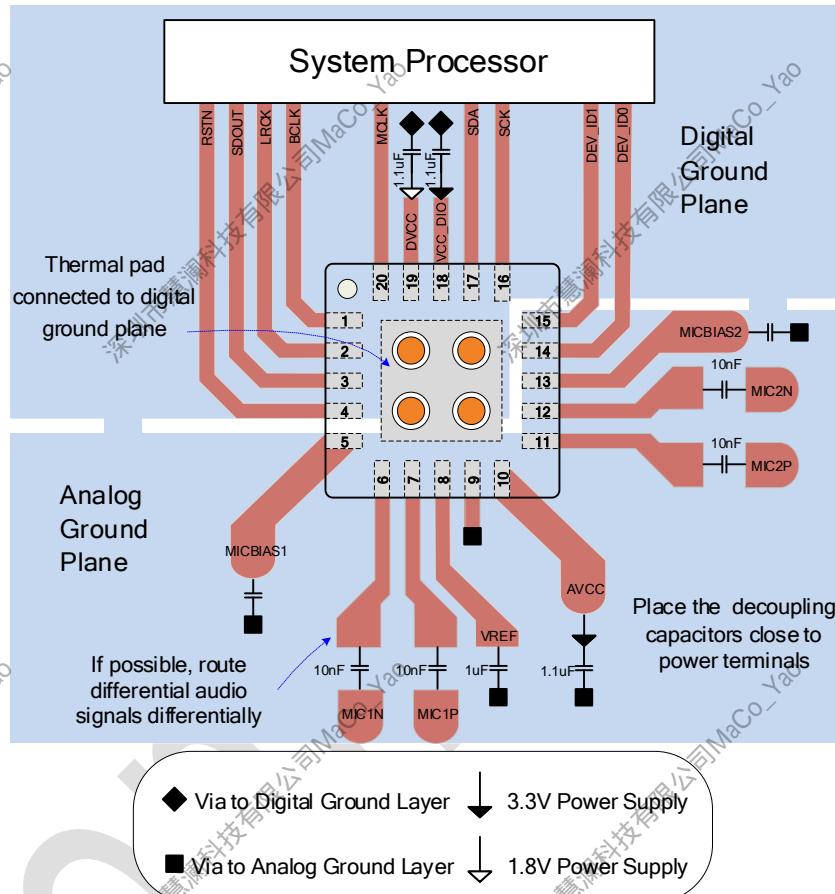
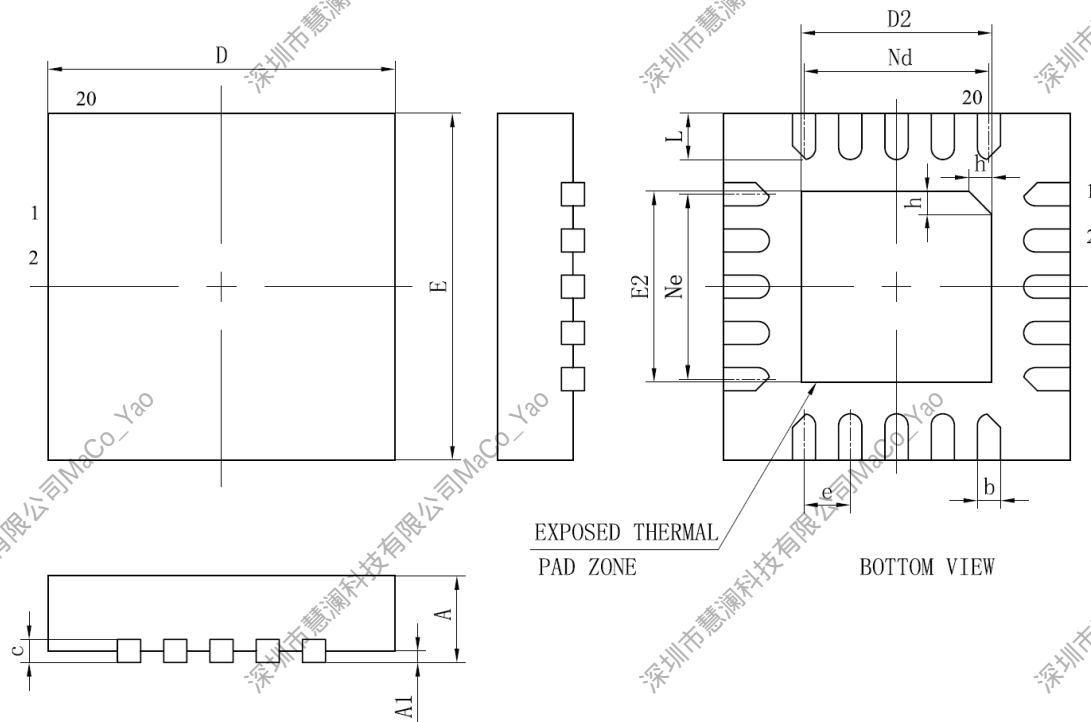


Figure 9-1. AC107 Recommended PCB layout

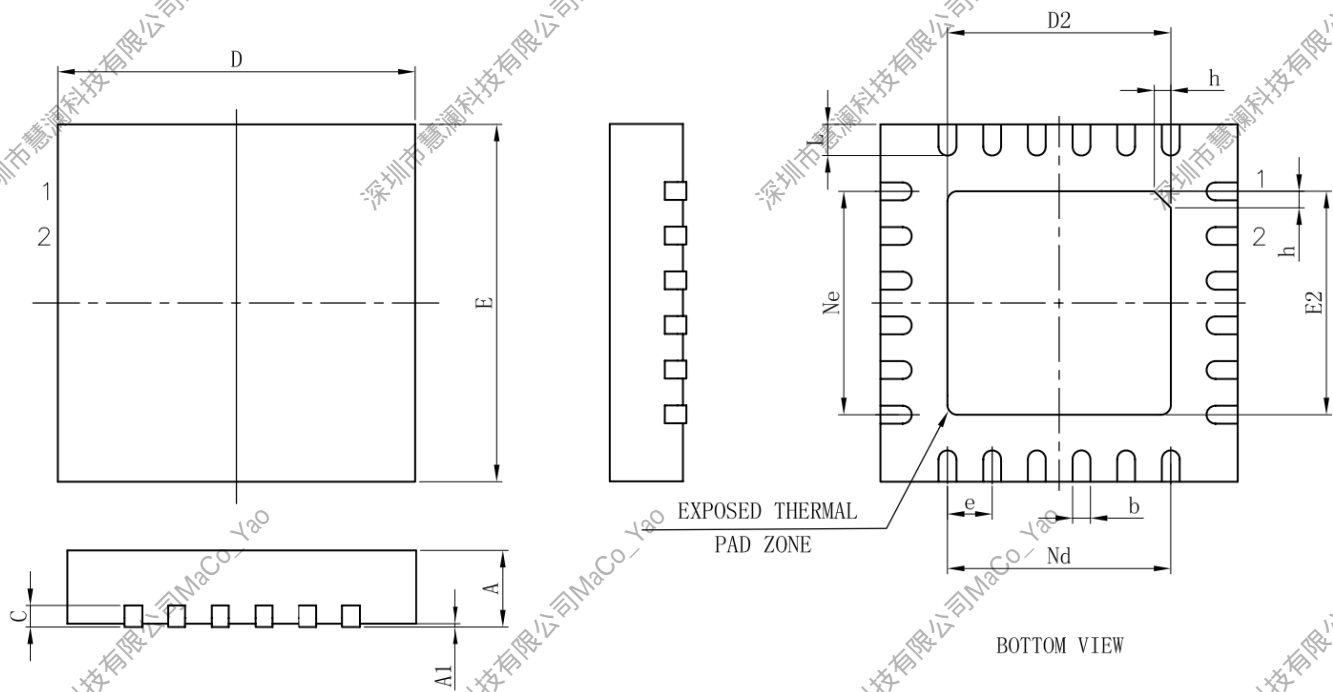
10 Package And Ordering Information

10.1 Package Information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	—	0.02	0.05
b	0.15	0.20	0.25
c	0.18	0.20	0.25
D	2.90	3.00	3.10
D2	1.55	1.65	1.75
e	0.40BSC		
Ne	1.60BSC		
Nd	1.60BSC		
E	2.90	3.00	3.10
E2	1.55	1.65	1.75
L	0.35	0.40	0.45
h	0.20	0.25	0.30
L/F载体尺寸 (MIL)	75*75		

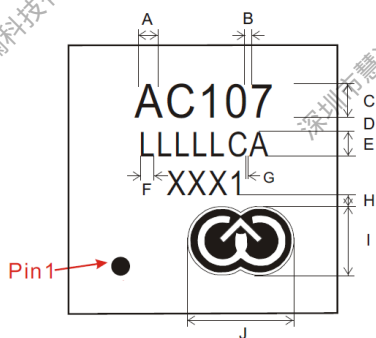
Figure 10-1 AC107 Package Dimension: 20 QFN



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	—	0.02	0.05
b	0.18	0.25	0.30
c	0.18	0.20	0.25
D	3.90	4.00	4.10
D2	2.40	2.50	2.60
e	0.50BSC		
Ne	2.50BSC		
Nd	2.50BSC		
E	3.90	4.00	4.10
E2	2.40	2.50	2.60
L	0.35	0.40	0.45
h	0.30	0.35	0.40
L/F载体尺寸	110x110		

Figure 10-2. AC107S Package Dimension: 24 QFN

10.2 Marking Information




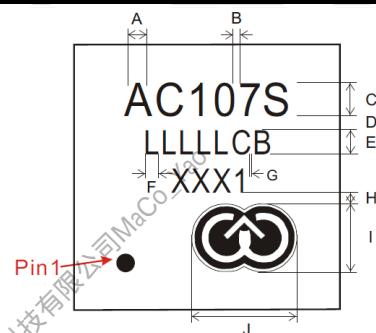
A	B	C	D	E	F	G	H	I	J
0.25	0.06	0.4	0.15	0.28	0.15	0.06	0.1	1.0	1.5

Unit: mm Size tolerance: $\pm 0.1\text{mm}$

Figure 10-3. AC107 Marking

Table 10-1. AC107 Marking Definitions

No.	Marking	Description	Fixed/Dynamic
1	AC107	Product name	Fixed
2	LLLLCA	Lot number	Dynamic
3	XXX1	Date code	Dynamic
4		X-POWERS logo	Fixed
5	White dot	Package pin 1	Fixed




A	B	C	D	E	F	G	H	I	J
0.3	0.15	0.5	0.2	0.35	0.2	0.1	0.2	1.1	1.7

Unit: mm Size tolerance: $\pm 0.1\text{mm}$

Figure 10-4. AC107S Marking

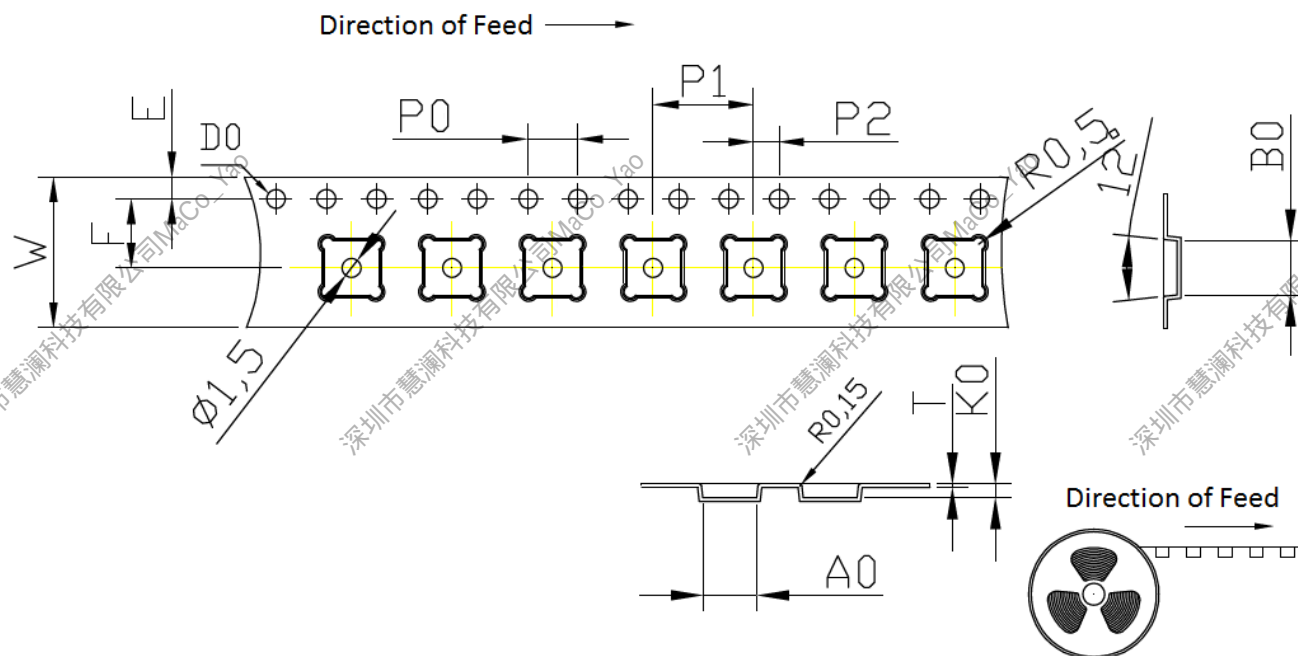
Table 10-2. AC107S Marking Definitions

No.	Marking	Description	Fixed/Dynamic
1	AC107S	Product name	Fixed
2	LLLLCB	Lot number	Dynamic
3	XXX1	Date code	Dynamic
4		X-POWERS logo	Fixed
5	White dot	Package pin 1	Fixed

10.3 Carrier

Table 10-3. Reel Carrier Information

Item	Color	Size
Reel	Blue	13 inches
Aluminum foil bags	Silvery white	440mm x 370mm x 0.15mm
Inside Box	White	336mm x 336mm x 48mm
Outside Box	White	423mm x 358mm x 365mm


Figure 10-5. Tape Dimension Drawing
Table 10-4. Tape Dimension

Device	W(mm)	A0(mm)	B0(mm)	K0(mm)	P0(mm)	P1(mm)
AC107	12±0.30	3.30±0.1	3.30±0.1	1.10 ^{+0.10} _{-0.05}	4.0±0.1	8.00±0.1
AC107S	12±0.30	4.30±0.1	4.30±0.1	1.10 ^{+0.05} _{-0.00}	4.0±0.1	8.00±0.1
Device	P2(mm)	F(mm)	E(mm)	D0(mm)	T(mm)	
AC107	2.0±0.1	5.5±0.1	1.75±0.1	1.5 ^{+0.10} _{-0.00}	0.3±0.05	
AC107S	2.0±0.1	5.5±0.1	1.75±0.1	1.5 ^{+0.10} _{-0.00}	0.3±0.05	

Table 10-5. Packing Quantity Information

Type	Quantity	Part Number
Tape Reel	3000pcs	AC107
Tape Reel	3000pcs	AC107S

11 REFLOW PROFILE

The reflow profile recommended in this document is a lead-free reflow profile that is suitable for pure lead-free technology of lead-free solder paste.

Figure 11-1 shows the typical reflow profile of AC107 device sample.

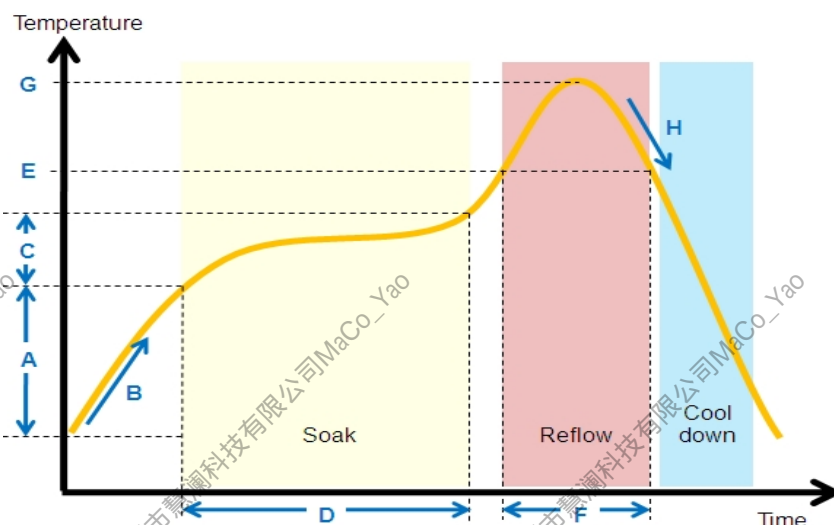


Figure 11-1 AC107 Typical Reflow Profile

Reflow profile conditions of AC107 device sample is given in Table 11-1.

Table 11-1 AC107 Reflow Profile Conditions

QTI typical SMT reflow profile conditions (for reference only)		
Environment	Step	Reflow condition
	N2 purge reflow usage (yes/no)	Yes, N2 purge used
	If yes, O2 ppm level	O2 < 1500 ppm
A	Preheat ramp up temperature range	25°C -> 150°C
B	Preheat ramp up rate	1.5~2.5 °C/sec
C	Soak temperature range	150°C -> 190°C
D	Soak time	80~110 sec
E	Liquidus temperature	217°C
F	Time above liquidus	60-90 sec
G	Peak temperature	240-250°C
H	Cool down temperature rate	≤4°C/sec

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